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## **Chemical Vapour Deposition**

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## 21 Abstract

Chemical vapour deposition (CVD) is a powerful technology for producing high-quality solid 22 thin films and coatings. While widely used in modern industries, it is continuously being 23 developed as it is adapted to new materials. Today, CVD synthesis is being pushed to new 24 heights with the precise manufacturing of both inorganic thin films of two-dimensional (2D) 25 materials and high-purity polymeric thin films that can be conformally deposited on various 26 substrates. In this Primer, an overview of the CVD technique including instrument construction, 27 process control, material characterization, and reproducibility issues is provided. By taking 28 graphene, 2D transition metal dichalcogenides (TMDs) and polymeric thin films as typical 29 examples, the best practices for experimentation involving substrate pre-treatment, high-30 temperature growth and post-growth processes are presented. Recent advances and scaling-up 31 challenges are also highlighted. By analyzing current limitations and optimizations, we also 32 provide insight into possible future directions for the method, including reactor design for high-33 throughput and low-temperature growth of thin films. 34

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- 35 [H1] Introduction
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Chemical vapour deposition (CVD) is a widely used materials-processing technology where 37 thin films are formed on a heated substrate via a chemical reaction of gas-phase precursors. In 38 contrast to physical vapour deposition methods, such as evaporation and sputtering, CVD offers 39 a clear advantage by relying on chemical reactions that enable tunable deposition rates as well 40 as high quality products with excellent conformality. The greater demand for semiconductor 41 thin films starting after World War II was the initial driving force for rapid development of CVD 42 technology<sup>1-5</sup>. Recently, low-dimensional materials such as carbon nanotubes, graphene, and 43 two-dimensional (2D) transition metal dichalcogenides (TMDs) have injected new vitality into 44 the electronics industry<sup>6-8</sup> and introduced more stringent requirements for successful CVD of 45 these materials with high purity and fine structure. CVD allows the tuning of the structures and 46 properties of the resulting products<sup>9</sup>, and a variety of advanced CVD systems and their variants 47 have been developed, such as plasma-enhanced CVD (PECVD)<sup>2</sup> and metal organic CVD 48 (MOCVD)<sup>4</sup> (BOX 1). Usually, CVD does not require high vacuum working environments, making 49 it a popular technology for electronics, optoelectronics, surface modification, and biomedical 50 applications. 51

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<sup>53</sup> Irrespective of the variations in CVD types, the fundamental process is similar and consists of <sup>54</sup> the following common elementary steps<sup>10,11</sup> (**Fig. 1**). First, the reactant gases are transported <sup>55</sup> into the reactor. These reactant gases then either react with each other in the gas phase to <sup>56</sup> form intermediate reactants and gaseous by-products via homogeneous reactions, or diffuse

directly through the boundary layer to the substrate. In both cases, the reactant gases and the 57 intermediate reactants adsorb onto the heated substrate surface and diffuse on the surface. 58 The subsequent heterogeneous reactions at the gas-solid interface lead to continuous thin film 59 formation via nucleation, growth, and coalescence as well as formation of reaction byproducts. 60 Finally, any gaseous products and unreacted species desorb from the surface and are carried 61 away from the reaction zone. The gas-phase reactions occur when the temperature is 62 sufficiently high or additional energy is introduced, for example, in the form of plasma. In 63 addition, the heterogeneous reaction is essential if the deposition reaction relies on the surface 64 catalysis of the underlying substrate, such as in the case of the catalytic growth of graphene on 65 metal surface. 66

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In this Primer, we first provide an overview of the CVD instrumentation setup before 68 describing best practices for material preparation and characterization using the growth of 69 graphene on metal and dielectric substrates as representative examples of catalytic CVD and 70 non-catalytic CVD processes, respectively. We then demonstrate the flexibility of this method 71 by discussing important applications of CVD, including growth of binary and ternary 2D 72 materials and polymeric thin films. We also highlight recent progress and challenges when 73 scaling-up this technology, an important aspect of CVD when applied to industry. Finally, we 74 discuss what affects experimental reproducibility, current limitations of the technique, and 75 future developments of CVD together with exploration of new materials. 76

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## 78 [H1] Experimentation

To obtain high-quality thin films by CVD, suitable equipment is needed, and custom-built 79 systems provides the flexibility of operation often desired by CVD researchers. In this section, 80 we will discuss a series of designs that satisfy the requirements of materials synthesis, including 81 the heating methods, gas-flow control, the loading of substrate, etc. In addition, the growth 82 parameters, including substrate, temperature, atmosphere, pressure etc. are essential for 83 controlling the quality of as-grown materials as well as the reaction rate (growth rate). Here, we 84 will introduce CVD growth of graphene following the procedure of substrate pretreatment, 85 heating, annealing, high-temperature growth and cooling. 86

### 87 [H2] CVD equipment

A CVD system must meet the following basic requirements: delivery of the gas-phase reactants in a controllable manner; provision of a sealed reaction chamber; evacuation of the gases and control of the reaction pressure; supply of the energy source for the chemical reactions; treatment of the exhaust gases to obtain safe and harmless levels; and automatic process control to improve the stability of the deposition process. **Fig. 2** shows a typical CVD system consisting of a gas delivery system, reaction chamber, vacuum system, energy system, exhaust gas treatment system, and automatic control system.

#### 95 [H3] Gas delivery system

Safety and process control are two of the key aspects of this design, especially considering the possibility of using high-pressure, toxic, flammable and explosive gas, liquid or solid precursors. The gaseous reactants are usually stored in high-pressure gas bottles placed in cool places outdoors or in cabinets at a constant negative pressure, to ensure safety. The gas supply line starts at the outlets of the high-pressure gas bottles, which are fitted with mechanical pressure regulators to control the pressure, and ends at the inlet of the reaction chamber. Valves (for example, ball shut off, needle shut off and pneumatic valves) and metal gasket seal connectors
 are often used to ensure a good sealing performance.

Mass flow controllers are essential for the gas supply, where the gas flow rate is automatically set via feedback control according to the mass of flowing gas. Liquid source reactants are delivered by "bubbling" a carrier gas controlled by the mass flow controller (**Fig. 2b**)<sup>12,13</sup>. Solid source precursors that are less volatile are introduced to the reaction chamber by dissolution in a suitable solvent<sup>14</sup> or by sublimation into the gas-phase <sup>15-21</sup>.

[H3] Reaction chamber

The horizontal (Fig. 2a)<sup>22-24</sup> and vertical (Fig. 2c-e)<sup>25,26</sup> configurations are the two main 110 configurations of the reaction chamber (**Box 1**). The reaction chamber itself is usually quartz 111 tube, widely employed in semiconductor manufacturing because of its tolerance to high 112 temperatures and to rapid heating and cooling. A gas inlet injector is connected to the chamber 113 using a metal flange, which is fitted with cooling components. To guarantee the gas flow is 114 laminar, a gas distributor with through-holes is usually employed (Fig. 2c-e)<sup>22,25</sup>. The substrate is 115 usually located on a substrate holder (also known as a "boat" or "susceptor") composed of 116 quartz or graphite because of their good chemical stability and high-temperature 117 resistance<sup>22,27,28</sup>. In order to meet the target deposition characteristics (thickness, composition, 118 etc.), the configuration of the substrate holder and the deposition conditions (total gas flow, gas 119 composition, temperature, pressure, etc.) must be optimized via experimental and numerical 120 process engineering studies<sup>22,25,26,29,30</sup>. In manufacturing applications, a cooling chamber with a 121 loading/unloading subsystem is necessary to improve the productivity. 122

[H3] Vacuum system

Purging the deposition chamber to start the deposition process and obtaining the necessary 124 pressure for transport of the reactants relies on the vacuum system, where measurement and 125 control of the vacuum are essential and complement one another. To measure the pressure of 126 the vacuum system, various gauges are alternated: the Bourdon gauge, piezo sensor, 127 128 capacitance manometer, and diaphragm manometer are the main mechanical gauges, which can measure the vacuum by detecting physical changes in the strain or electrical capacitance, 129 for example. The Bourdon gauge is inexpensive and has a long life, but it does not have an 130 electronic output, and so is not suitable for feedback control (Fig. 2f). Using a capacitance 131 manometer, a measurement range of four orders of magnitude can be achieved for almost any 132 gas, and the signal can be transported to an electronic display or a feedback controller (Fig. 2g). 133 The diaphragm manometer operates the same way as the capacitance manometer, only with a 134 smaller range of measurement. In addition, gas property gauges, such as thermocouple gauges 135 and the Pirani gauge, are inherently inaccurate, since their value is determined by the types of 136 gases and temperatures; however, when calibrated, they can be used to measure certain 137 conditions. Furthermore, ionization gauges are commonly employed under high or ultra-high 138 vacuum conditions. 139

To control the pressure, the use of a throttle valve or a needle valve is effective, and the downstream flow rate can be controlled by adjusting the opening degree of the valve gate<sup>31</sup>. The chamber pressure will then stabilize when the flow rate of the incoming gas is equal to that of the exhaust, which can be automatically or manually controlled by real-time pressure
 monitoring<sup>31</sup>.

Pumps provide the driving force for the vacuum and mass-transport within the system. For a CVD system, mechanical pumps are adequate for many operations, and can provide a vacuum of 1 Pa. Oil pumps are cheaper than dry pumps of the same power, but bring additional contaminants into the system. If the reaction chamber is large, a rotary pump (pumping speed ranging from 0.5 - 325 L s<sup>-1</sup>) with a Roots pump (50 - 35,000 L s<sup>-1</sup>) is a good choice for fast exhaust. Finally, a vacuum isolation valve (also known as a block valve) is used between the outlet of the CVD chamber and the pump to shut off the pumping process.

## 152 [H3] Energy system.

For a thermal CVD process, the heating components, thermal insulation structure, and 153 temperature measuring elements are important. Fig. 2a shows a common resistance heating 154 furnace, which consists of three heating zones and aluminum silicate insulating cotton to 155 ensure a uniform temperature field over a sufficient length. Thermocouples, which are the 156 most common temperature measuring device, are placed between the quartz tube and the 157 heating components, and are connected to a proportional-integral-derivative (PID) regulator. 158 Several types of thermocouples exist (including B, K, R and S), which are suitable for application 159 under different conditions<sup>32</sup>. In the case of a large reactor (diameter >25 cm), the inclusion of 160 thermocouples inside the chamber is necessary to calibrate the temperature. Cold-wall reactors 161 most frequently use a graphite heater that introduces an electrical current into the 162 chamber<sup>29,33</sup>, and a pyrometer is commonly employed to measure the temperature. Plasma can 163

also be used to provide energy by electrical discharge of the gaseous media; in this case, the
 electron temperatures are significantly higher than the neutral and ion temperatures<sup>34,35</sup>. As an
 example, an inductively-coupled plasma source is illustrated in Fig. 2a , and this can be placed
 against part of the reaction chamber for facile integration into the tube reactor. The geometry
 and materials of the substrate holder also influence the heat transfer, while radiant heating
 with a halide lamp<sup>36</sup>, electric induction<sup>37</sup>, or laser can be used to specifically heat the substrate.

170 [H3] Exhaust gas treatment system

The by-products and unreacted chemical substances of CVD tend to be flammable, toxic or 171 harmful to the pumps, and therefore must be safely treated. This is usually done with either 172 one or a combination of components such as cold traps, chemical traps, particle traps, wet 173 scrubbers and vents<sup>14,18</sup>. A cold trap is used to condense volatile gases and cool exhaust gases 174 to stop the temperature of the vacuum pump oil from increasing. In addition, various corrosive 175 gases can be reacted or adsorbed by passing through a chemical trap, and a particle trap can 176 provide protection against pump wear. To further convert the exhaust into harmless substances, 177 a burning component or a wet scrubber can also be employed<sup>32</sup>. 178

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## [H2]Experimental methods for materials growth

Here, we introduce the material preparation process by using graphene as an example (**Fig. 3**). Graphene is a nanomaterial consisting of single layer sp<sup>2</sup> bonded carbon atoms that is challenging to synthesize in a controllable manner because the growth of high-quality monolayer graphene films requires a catalytic metal substrate, although thicker graphene can
 be grown on a non-catalytic insulating substrate as long as a higher temperature or additional
 energy supply is available to promote decomposition of the precursors.

[H3] Substrate pre-treatment

Selecting an appropriate substrate is essential for CVD growth because different substrate 189 catalytic abilities and carbon solubilities result in different graphene growth modes. Transition 190 metals (for example, copper and nickel)<sup>38,39</sup> and insulating substrates (for example, SiO<sub>2</sub>, Al<sub>2</sub>O<sub>3</sub>, 191 and glass)<sup>40-42</sup> are typical substrates on which the heterogeneous catalytic reaction and the gas-192 phase reaction dominate the growth processes, respectively. To grow high-quality graphene, 193 cleaning of the substrate is necessary. Electrochemical polishing, for example on copper foil, 194 can be employed to reduce the level of contaminants and decrease the surface roughness (Fig. 195 3a). As for silicon wafers or sapphire wafers, typical cleaning procedures employed in the 196 semiconductor community (such as picking) are applicable (Fig. 3e). 197

## [H3] Heating and annealing

After loading the substrate onto the substrate holder and transporting it to the desired location in the CVD chamber, the gate is closed and the chamber is checked for any air leakage. The substrate is then heated to 1000 °C and annealed under a non-reactive atmosphere (**Fig. 3b**). During this procedure, the introduction of very small quantities of oxygen into the chamber can aid in reducing the nucleation density of graphene by burning any carbon-containing contaminants<sup>43,44</sup> that could seed graphene during the growth process. Hydrogen is commonly introduced to reduce and activate the weakly oxidized copper surface. In addition, a **10**/**63**  temperature gradient is beneficial for preparing a single crystal metal substrate to promote
 subsequent graphene growth (Fig. 3b)<sup>28,45-47</sup>.

[H3] High-temperature growth

Graphene growth is initiated by introducing a hydrocarbon precursor (methane is most 209 commonly used) that decomposes into active carbon species to fuel growth of graphene. If the 210 substrate is a metal with a relatively high catalytic ability and a low carbon solubility, such as 211 copper, the hydrocarbon precursors are initially adsorbed onto the substrate prior to step-by-212 step decomposition into active carbon species under the form of  $CH_x$  (x = 3, 2, 1, 0)<sup>48</sup>. 213 Subsequent growth takes place through nucleation, growth and coalescence of the graphene 214 seeds to produce a continuous film (Fig. 3c)<sup>49,50</sup>. During the nucleation stage, the nucleation 215 density and orientation of the nuclei determining the domain size of the graphene film are 216 influenced by temperature, the concentration of active carbon species, the surface properties 217 of substrate, etc. In the surface catalysis-dominated process, the formed graphene islands 218 continuously expand until they merge into a film: this is called the self-limited growth mode. 219 Research on the growth kinetics of this self-limited mode is essential to increase the growth 220 rate and improve the graphene quality. According to the Arrhenius equation  $k = Ae^{\frac{-E_a}{RT}}$ , the 221 growth rate k is exponential with  $-E_a/T$ , where  $E_a$  is the growth activation energy, T is 222 temperature, and R is the universal gas constant. Various strategies are effective at increasing 223 the growth rate and include introducing surface oxygen, employing metals with high catalytic 224 activity, or increasing the temperature and concentration of the precursors. However, the gas-225 phase reaction when catalyzed on the surface of the metallic substrate can produce significant 226

amounts of by-products and induce the formation of amorphous carbon contaminants<sup>20,51</sup>,
which is often overlooked.

For non-metallic substrates (for example, SiO<sub>2</sub> or Al<sub>2</sub>O<sub>3</sub>), if the precursor concentration and 229 temperature are both sufficiently high, the thermally-decomposed active carbon species can 230 deposit onto the substrate and form a graphene film (Fig. 3f)<sup>30,40,41,52</sup>, where gas-phase 231 decomposition reactions plays a crucial role. In this case, employing high-energy plasma can 232 promote the decomposition of the carbon precursor and lower the growth temperature 233 (<600°C)<sup>34</sup>. However, due to a lack of catalytic activity from the substrate and a reaction 234 temperature below the graphitization temperature, the quality of the graphene grown using 235 this setup is poor compared to graphene grown on a copper surface  $^{9,42}$ . 236

## [H3] Cooling

The cooling process also contributes to the growth of graphene. If the substrate is a metal with 238 a high carbon solubility, such as nickel, the carbon dissolved in the bulk nickel will segregate 239 and form few-layer graphene sheets<sup>11,53</sup>. Through designing a synergistic binary alloy (such as 240 Cu/Ni, Ni/Mo, Co/Mo) as a substrate and controlling the cooling rate, the number of graphene 241 layers that form can be controlled during the segregation process (Fig. 3d)<sup>54,55</sup>. The thermal 242 expansion mismatch between graphene and its underlying substrate will also result in wrinkles 243 (standing collapsed structures on the graphene surface) and folds (folded wrinkles or folded 244 graphene) during cooling (Fig. 3g)<sup>56-59</sup>. The carbon solubility<sup>60</sup> in 1000 °C and thermal 245 expansion<sup>61</sup> of typical substrates are listed in Table 1. 246

Finally, fast cooling, which is achieved by either moving the samples out of the hot zone or by 247 moving the furnace, is commonly employed to increase production efficiency<sup>9,62</sup>. A 248 programmable cooling procedure can also be used to achieve a desired structure in the 249 produced materials<sup>62,63</sup>. As a rule of thumb, the flow rates of reactant gases (such as hydrogen 250 and methane) are usually maintained during the cooling process to protect the as-formed 251 graphene film from etching by oxygen leaked from the atmosphere. After the temperature 252 drops below 100 °C, the furnace chamber gate can be opened and the samples can be unloaded 253 from the substrate holder. 254

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## [H1] Results

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CVD is directly related to some of the properties of the as-grown materials. In order to assess 258 the CVD method, the as-grown materials must be characterized in-depth to obtain 259 morphological and structural information. Using the CVD growth of graphene as an example, 260 we describe a number of characterization methods to assess the macroscopic quality, atomic 261 structure, electronic structure, and purity of the resulting graphene (Table 2). A transfer process 262 of the as-grown graphene from the metal catalytic substrate to a target substrate is usually 263 necessary when assessing graphene quality because an appropriate substrate is important for 264 some characterization techniques. 265

## [H2] Assessing materials quality and structure

<sup>267</sup> Optical microscopy<sup>9, 68</sup> is a simple and quick tool to identify the macroscopic morphology of <sup>268</sup> graphene. Its lower resolution yields information such as the location of graphene on the 13/63

substrate, the number of graphene layers and their shape, etc. Optical microscopy is widely 269 used for exfoliated graphene on SiO<sub>2</sub>/Si, but is only effective on some silicon substrates with a 270 specific oxide thickness such as 90 nm and 280 nm<sup>64</sup>. For CVD-grown graphene on metal 271 substrates such as copper, nickel, platinum, rhuthenium, etc., the graphene usually first needs 272 to be transferred onto these SiO<sub>2</sub>/Si substrates for optical microscopy observation (**Fig. 4a**)<sup>65-68</sup>. 273 However, for the case of graphene grown on copper, selectively oxidizing the graphene/copper 274 interface can cause the oxidized copper to act as a specific substrate<sup>69-71</sup> and reveal the 275 graphene individual domain [G] shapes, surface coverage, layer numbers or grain boundaries. 276 Graphene domains are delineated by grain boundaries, thus increasing the crystal size of the 277 substrate as well as bonding uniformly-oriented grains seamlessly will help minimize the 278 concentration of grain boundaries. In addition, the multi-function optical microscopy modes of 279 dark-field or polarized light can also increase the image contrast<sup>72</sup>. 280

Scanning electron microscopy (SEM) is another popular tool to characterize the morphology of 281 graphene, as it provides nanoscale spatial resolution and greater depth of field than optical 282 microscopy. It utilizes the attenuation effect of graphene layers on secondary electrons emitted 283 from the underlying substrate<sup>7,69,73,74</sup>. Normally, in SEM images, a graphene-covered region is 284 darker than the bare substrate (including metal and SiO<sub>2</sub>/Si). The color of these regions darkens 285 as the number of graphene layers increases, which is beneficial for distinguishing the layer 286 number of graphene (Fig. 4b)<sup>43,75</sup>. The side-attached Everhart-Thornley detector is the most 287 frequently used, which allows high contrast images at low acceleration voltage ( $V_{acc} \leq 5$  kV). The 288 electron energy and density of electron beam should be carefully set according to the 289

conductivity of the substrate because the electron beam will inevitably break atomic lattices ingraphene.

Atomic force microscopy (AFM) is an important method to measure surface morphology at a 292 subnanometer-scale resolution<sup>7,39,67</sup>, and its multi-functions can also measure mechanical, 293 electrical and magnetic properties<sup>76</sup>. AFM scans a sharp tip over a sample surface without 294 electron or photon interactions. The surface roughness, thickness, cleanliness, wrinkles, domain 295 sizes and shapes, as well as the bonding status of CVD-grown graphene can all be obtained by 296 this technique (**Fig. 4c-d**)<sup>51,77-79</sup> for both graphene on its original substrate and graphene 297 transferred on an insulating substrate. Owing to the van der Waals interactions between 298 graphene and the underlying substrate, the thickness of monolayer graphene is usually 299 between 0.6 nm and 1.5 nm, which is much larger than graphene's interlayer spacing of 0.34 300 301 nm.

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#### <sup>303</sup> [H2] Assessing atomic structure

CVD-grown graphene can be affected by adsorbed atoms and molecules, and display distorted lattices, grain edges, or grain boundaries, so it is important to analyze its atomic structure. Similar in operation to AFM, scanning tunneling microscopy (STM) is another proximal probe imaging technology based on the quantum tunneling effect. It has very high spatial resolution because of the exponential relationship between the tunneling current and the distance between the conducting surface and the sharp scanning tip, which means the honeycomb lattice of graphene or its morphology over hundreds of nanometers with atomic resolution can

be easily acquired<sup>80</sup>. Being a surface-sensitive technique, STM characterization requires that the 311 graphene be on a conductive and ultra-smooth substrate. STM images clearly present the point 312 defects, atomic structures of grain boundaries, or the edges of graphene<sup>80-82</sup>, with zigzag edges 313 preferred in CVD-grown graphene grains on various metals (FIG. 4e)<sup>80,83-85</sup>. STM also confirms 314 that CVD-grown graphene films retain continuous atomic lattices over metal steps and perfect 315 lateral heterostructure between graphene and hexagonal boron nitride (*h*BN) (FIG. 4f)<sup>86-89</sup>. The 316 strong coupling between graphene and the growth substrate often gives rise to Moiré patterns 317 (FIG. 4g), and these superstructures vary with their twist angles and the strength of their 318 interactions<sup>57,90-92</sup>. 319

Transmission electron microscopy (TEM) is a commonly used technique to image the atomic 320 structures of lattices, strains, defects, grain boundaries<sup>93-96</sup> of materials, including graphene and 321 other 2D materials. It has very high resolution, with a recently demonstrated lateral resolution 322 lower than 0.1 nm<sup>97</sup>. Samples for TEM imaging must be suspended or supported on an ultra-323 thin film, so designed micro-grids with through-holes or a carbon membrane are usually 324 employed. If the TEM is fitted with an aberration corrector, the operation voltage can be 325 reduced and a subnanometer-scale resolution can be achieved. By using an aberration-326 corrected annular dark-field scanning TEM (ADF-STEM), graphene's grain boundary structures 327 with distorted pentagonal, heptagonal and octagonal rings have been observed (Fig. 4h)<sup>94</sup>. 328

In addition to the above techniques, electron backscatter diffraction (EBSD) <sup>46</sup>, X-ray diffraction (XRD) <sup>98,99</sup>, selected area electron diffraction (SAED)<sup>100</sup> and low energy electron diffraction (LEED)<sup>96</sup> are also used to characterize CVD-grown graphene. EBSD and XRD are usually used to measure the crystalline orientation of the growth substrate, such as Cu(111), Pt(100), Ru(0001), etc. SAED implemented in a TEM is usually used to confirm the crystalline orientation of graphene, and the SAED pattern can be used to calibrate the lattice constant of graphene. The measurement conditions of LEED requires an ultra-high vacuum and an ultra-smooth surface, and its reduced operation voltage is safer for most 2D materials.

#### <sup>337</sup> [H2] Assessing electronic structure and purity

Spectroscopic techniques can provide information regarding the bonding status, electronic structures and purity of CVD graphene through the interactions between atomic lattices and photons with different energies.

Graphene was characterized early on using Raman spectroscopy<sup>101,102</sup>, which relies on Raman 341 scattering [G] and provides information about lattice vibrations (i.e. phonons) in materials. 342 Similar to exfoliated graphene on SiO<sub>2</sub>/Si, the Raman spectrum of CVD-grown graphene mainly 343 consists of four vibration modes<sup>101</sup>: a layer-dependent C peak ( $29 - 44 \text{ cm}^{-1}$ ), a defect-344 dependent D peak (1340 – 1380 cm<sup>-1</sup>), a hexagonal lattice-dependent G peak (1550 – 1620 cm<sup>-1</sup>) 345 <sup>1</sup>), and a 2D peak by two phonons process (2650 – 2760 cm<sup>-1</sup>). All the above values are collected 346 using a laser wavenumber of 532 nm. By fitting the experimental data with a Lorentzian 347 function, the position, shape, full-width-at-half-maximum and relative intensity of the Raman 348 peaks can be obtained, from which information such as the layer number, defects, strain, and 349 doping level of CVD-grown graphene can be extracted (**Fig. 4i-j**)<sup>66,103,104</sup> for both graphene on 350 metals and graphene transferred on other substrates. As an example, during CVD of graphene 351 on metal, the metal substrate and the high temperature will introduce doping and strain in the 352 graphene: this is easily characterized by the shift and relative intensity ratio of the G peak and 353

<sup>354</sup> 2D peak compared to graphene's intrinsic status<sup>78,90</sup> (i.e. when it is in its suspended exfoliated <sup>355</sup> initial state). In addition, CVD-grown graphene usually has point defects, grain boundaries, or <sup>356</sup> wrinkles, all of which contribute to the D peak<sup>105,106</sup> (**Fig. 4j**).

CVD graphene usually couples with the metal substrates, which alters its electronic structure 357 significantly and causes it to exhibit p-type or n-type doping, an opened bandgap, etc.<sup>107</sup>. These 358 effects can be detected by angular resolution photoemission spectroscopy (ARPES) <sup>108</sup> and 359 scanning tunneling spectroscopy (STM)<sup>90</sup>. The Dirac core of graphene in its intrinsic state is 360 located at the Fermi level, while the position of the Dirac point for CVD graphene on metals 361 usually shifts because of the charge transfer to or from the growth substrates<sup>107-109</sup>. For 362 example, the Dirac point for monolayer graphene grown on copper is usually found at -450 – -363 300 meV with n-type doping and a bandgap of 50 – 350 meV (FIG. 4k)<sup>110</sup>. In contrast to the 364 large scanning area by angular resolution photoemission spectroscopy, scanning tunneling 365 spectroscopy detects the electronic structure at atomic resolution. Similarly to STM, it requires 366 graphene to have a conductive and smooth substrate, and can measure the doping type, 367 bandgap and the density of states at the atomic scale (**Fig. 4I**)<sup>90</sup>. 368

For heterogeneous doping in CVD-grown graphene, X-ray photoelectron spectroscopy, energy disperse spectroscopy and electron energy loss spectroscopy (EELS) yield the binding energy, element species and the relative elemental ratio<sup>111</sup>. With energy disperse spectroscopy or electron energy loss spectroscopy equipped to a TEM, the element distribution can also be imaged at atomic resolution.

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## 376 [H1] Applications

In addition to graphene, 2D materials consisting of two or more elements such as TMDs, *h*BN, Mo<sub>2</sub>C, Bi<sub>2</sub>O<sub>2</sub>Se, etc. and polymeric thin films can also be successfully synthesized by CVD. In contrast to growing graphene, synthesizing TMDs requires more complicated growth parameters because of the solid precursors and phase control needed. Compared to traditional solution-based polymerization, the CVD synthesis of polymeric thin films shows its unique advantages in terms of conformity and high-purity.

[H2] CVD for 2D materials growth

CVD is the most widely used method for making high quality monolayer TMDs in a laboratory 384 setting<sup>112-114</sup>. The simplest method is thermal CVD<sup>115</sup>, where powders of precursors are 385 sublimated at high temperature to form a vapour that condenses as single crystal monolayered 386 TMDs on substrates without substrate-assisted catalysis. Thermal CVD results in deposition of 387 discontinuous triangular crystals along with amorphous and multi-layered products. Despite 388 this, its simplicity and accessibility have made it the most widely studied and utilized method 389 for synthesis of high quality TMDs such as MoS<sub>2</sub>, WS<sub>2</sub>, WSe<sub>2</sub>, MoSe<sub>2</sub> and their 390 heterojunctions<sup>116-118</sup>. In thermal CVD synthesis of TMDs, the reaction chamber (usually a tube 391 furnace as shown in Fig. 5) is typically heated to 650 - 900 °C in a nitrogen (N<sub>2</sub>) environment. At 392 this high temperature, the precursor powder (such as  $MoO_3$  for  $MoS_2$ ) is reduced by the sulfur 393 vapour to form volatile suboxides (e.g.  $MOO_{3-x}$ ). These suboxide compounds then diffuse to the 394 substrate and further react with sulfur vapour to grow MoS<sub>2</sub> films in the form of triangles 395 (shown in the optical microscopy image in Fig. 5) that are single layers. 396

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While uniform and continuous growth of TMDs with thermal CVD is difficult to achieve, some 398 progress has been made on increasing the size of the monolayer crystals by adding salt (NaCl) 399 to the precursors<sup>119</sup>. The role of salt is not yet clear but it likely facilitates the sublimation of 400 transition metal precursors, even as Na or Cl can be introduced as impurities in the as-grown 401 material. Theoretical work has shown that presence of sodium on the substrate can influence 402 the formation kinetics of  $MoS_2^{120}$ . The role of sodium on the rapid growth of  $MoS_2$  was verified 403 by producing large-area MoS<sub>2</sub> monolayers on soda-lime glass (composed of SiO<sub>2</sub>, Na<sub>2</sub>O and 404 CaO)<sup>121</sup>. Another challenge in thermal CVD of TMDs is the nucleation of monolayers on 405 technologically relevant substrates that are typically atomically smooth. Graphene-like 406 molecules such as PTAS (perylene-3,4,9,10-tetracarboxylic acid tetrapotassium acid salt) and 407 PTCDA (perylene-3,4,9,10-tetracarboxylic dianhydride) have been used as seed promoters and 408 templated growth of TMDs<sup>122</sup>. In addition, since nucleation of monolayer crystals occurs at 409 atomic edges, substrates such as sapphire with abundant atomic steps have also proved useful 410 in achieving large monolayer crystals<sup>123</sup>. 411

Recently, significant effort has been devoted to achieving highly uniform wafer scale TMD films 412 using metal-organic CVD (MOCVD)<sup>122,124</sup>. MOCVD vaporizes metal-organic precursors of both 413 the transition metal and the chalcogen at lower than growth temperatures to achieve uniform 414 monolayer TMDs. For MOCVD growth of wafer-scale MoS<sub>2</sub> and WS<sub>2</sub> <sup>124</sup>, molybdenum 415 hexacarbonyl (Mo(CO)<sub>6</sub>), tungsten hexacarbonyl (W(CO)<sub>6</sub>), and diethyl sulphide (( $C_2H_4$ )<sub>2</sub>S) for 416 Mo, W, and S were used as sources. The precursors are directly introduced into a growth 417 furnace heated at 550°C in an H<sub>2</sub> and Ar atmosphere. The key to uniform and continuous 418 monolayers with MOCVD is that the number of nucleation sites is kept low and the lateral 419 20 / 63

growth from those nuclei is allowed to proceed very slowly – it took over 26 hours to fully cover
 the surface of a 4-inch Si wafer (~10 cm in diameter)<sup>124</sup>. MOCVD also allows precise control of
 the concentration and supply of the precursors.

Similarly to thermal CVD, alkali metal salts also play a crucial but somewhat unclear role in the synthesis of large domains and the suppression of nucleation sites in MOCVD. NaCl can suppress nucleation and achieve monolayer growth of  $MoS_2$  <sup>125, 131</sup>. In NaCl-assisted growth, the salt is typically placed with the substrates in the furnace, which is not a scalable strategy. The average lateral size of  $MoS_2$  in salt-assisted growth was found to be ~60 µm with an electron mobility of 100 cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup> at cryogenic temperatures, indicating the high crystalline quality of the salt-assisted as-grown  $MoS_2$ <sup>126</sup>.

The most common TMDs synthesized with thermal and MOCVD growth are MoS<sub>2</sub>, WS<sub>2</sub>, MoSe<sub>2</sub> 430 and WSe<sub>2</sub> (Table 3). While significant effort has also been devoted to growing monolayers of 431 metallic TMDs (e.g. NbS<sub>2</sub>, TaS<sub>2</sub> and VS<sub>2</sub>  $^{127,128}$ ), these are difficult to grow with CVD because the 432 powder transition metal or metal oxide precursors require very high processing temperatures 433 and equivalent metal organic precursors have yet to be developed. Despite this difficulty, CVD 434 has been used to synthesize forms of niobium disulfide (Nb<sub>1.35</sub>S<sub>2</sub>) that possess very high 435 electrical conductivity<sup>128</sup>. Molten salts can also play a role in reducing the melting points of 436 precursors to form oxychlorides, which in turn can help with increasing the rate of growth of 437 metallic TMDs. In a method for synthesizing metallic TMDs (TiS<sub>2</sub>, PtSe<sub>2</sub>, PtTe<sub>2</sub>, NbS<sub>2</sub>, NbSe<sub>2</sub>, 438 NbTe<sub>2</sub>, VS<sub>2</sub>, and VSe<sub>2</sub>, etc.) using molten salts<sup>127</sup>, metal oxide precursors like Nb<sub>2</sub>O<sub>5</sub> were mixed 439 with NaCl powder and used thermal CVD to grow triangular monolayers. 440

21 / 63

In addition to 2D TMDs, other 2D binary compounds such as hBN, Mo<sub>2</sub>C and ternary Bi<sub>2</sub>O<sub>2</sub>Se 441 can also be successfully grown using CVD (Table 3). hBN is a 2D insulator with a bandgap of 5.9 442 eV, and plays an important role in advanced electronic devices as a gate dielectric layer or a 443 protecting encapsulator. CVD growth of hBN looks very similar to graphene in many aspects 444 (substrate, carrier gas, temperature), except for the solid precursor ammonia borane ( $NH_3$ -BH<sub>3</sub>), 445 which is the most frequently used  $^{98,129,130}$ . 2D Mo<sub>2</sub>C, a 2D transition metal carbide, belongs to a 446 family of materials that shows many intriguing properties such as excellent catalytic activity and 447 superconductivity. Large areas of Mo<sub>2</sub>C have been grown using methane as a precursor and 448 molybdenum as a substrate, where a copper foil on molybdenum melts during heating and 449 forms an Mo-Cu alloy that serves as diffusion layer for molybdenum atoms and guarantees the 450 chemical reaction leading to the formation of  $\alpha$ -Mo<sub>2</sub>C crystals<sup>131</sup>. Similarly, TaC can also be 451 grown by using tantalum as a substrate<sup>132</sup>. Finally, ternary 2D compounds such as Bi<sub>2</sub>O<sub>2</sub>Se can 452 also be successfully grown by rationally designing the precursors and the substrate. For 453 example, 2D Bi<sub>2</sub>O<sub>2</sub>Se is a semiconductor with high carrier mobility, in which the interaction 454 between the charge-carried layers is stronger than the Van der Waals interactions<sup>133</sup>. Therefore, 455 to therefore achieve atomically thin films and avoid vertical growth, mica and SrTiO<sub>3</sub> have been 456 used as substrates to exploit the stronger interaction<sup>19,134</sup>. 457

<sup>458</sup> [H2] CVD for growing polymeric thin films

Complementing well-established solution-based methods, CVD extends the realm of utility for polymer thin films<sup>135,136</sup>. CVD is compatible with insoluble macromolecules including many fluoropolymers, electrically conductive polymers and cross-linked organic networks. Its low growth temperatures (typically around 25 °C) and solvent-free nature allow CVD polymers to form directly on fragile substrates including papers, textiles and plant leaves, without a costly or complex transfer step. CVD polymerization even can be accomplished directly onto lowvolatility liquid surfaces<sup>136,137</sup>. CVD polymers can have high purity since the small molecule reactants used are easily purified and there is no possibility of residual solvent in the films<sup>135</sup>. Low defect levels are essential for device applications as well as for surfaces interacting with living cells and tissues<sup>138</sup>, as highighted below.

CVD polymeric layers can conformally follow the geometrical features of the underlying surface, 469 yielding the same film thickness in all locations <sup>139</sup>. Such conformal coverage is essential for 470 coating three-dimensional devices, modifying the internal surfaces of porous materials and 471 membranes, and for maintaining open pores in breathable fabrics and wearable electronics. In 472 contrast, solution coatings are typically non-conformal, as surface tension can blanket the top 473 of a porous surface without coating the interior of the pores. When blanketing closes off pores, 474 surface area is lost for interfacial processes like catalysis and molecular separations. . Shear 475 thinning, capillary forces and meniscus formation present in liquid-based coating processes also 476 cause variations in film thickness over the geometric features in the substrate. The absence of 477 surface tension in CVD processes also avoids pinhole formation by de-wetting even in sub-10 478 nm thick CVD polymer films<sup>136</sup>. Ultrasmooth CVD polymers (< 1 nm root mean square 479 roughness) also reduce pinhole formation produced by excursions in surface roughness which 480 exceed the film thickness. 481

The properties and reactivity of CVD polymers can be tuned and optimized at both the surface and in the bulk via their organic functional groups<sup>135,136</sup>. To date, dozens of organic functional

23 / 63

groups have been incorporated into CVD polymers and include amine, carboxylic acid, epoxy, hydroxyl, perfluorocarbon, and zwitterionic moieties. Many of these organic functional groups permit further surface functionalization of CVD polymers with biomolecules and nanoparticles<sup>135</sup>. High densities of organic functional groups can lead to changes in film thickness and changes in properties in response to external variations such as temperature, humidity, light or pH<sup>140,141</sup>. Such responsive CVD polymers have been demonstrated for sensing and actuation, smart surfaces, molecular separations and controlled drug release<sup>142-144</sup>.

The functional groups of CVD polymers can also be used to control surface energy from 491 superhydrophobic to superhydrophilic. Low surface energy lubricious CVD polymer release 492 layers are used commercially, for example in molds used to manufacture rubber tires and in 493 seals and gaskets used in advanced manufacturing <sup>145</sup>. Hydrophobic CVD fluoropolymer 494 conformal nanolayers maintain stamp features fidelity during high speed flexographic 495 printing<sup>146</sup>. The precision of surface energy control achieved with conformal CVD polymers has 496 also been exploited in directed self-assembly processes for defining sub-10 nm features and for 497 patterning substrates with 3D topography<sup>147-149</sup>. 498

<sup>499</sup> Dielectric CVD polymers are commercially used for protection of electronic and medical <sup>500</sup> devices<sup>135</sup>. CVD organic insulators have also been integrated into lightweight and mechanically <sup>501</sup> flexible devices, including thin film transistors, logic circuits, flash memory and energy <sup>502</sup> harvesting<sup>136,150</sup>. Conformal hybrid organic/inorganic polymer thin films containing boron or <sup>503</sup> phosphorous have enabled the doping of 3D Fin Field Effect Transistors<sup>151</sup>.

24 / 63

Electrically conducting CVD polymers are attractive as flexible transparent conductors for 504 optoelectronic devices, electrochemical energy storage, and electrocatalysis<sup>152</sup>. The 505 conductivity of CVD-grown polymer films can be 6000 S cm<sup>-1 153</sup>, exceeding the values of all 506 previously reported conducting polymer thin films<sup>154</sup> and reaching into the standard range for 507 conductivity of brittle transparent inorganic conductors such indium tin oxide (ITO). In addition, 508 a resurgence of interest in the thermal properties of CVD conjugated polymers is driven by 509 thermoelectric energy harvesting, as CVD polymers as thin as 2 nm have been incorporated into 510 nanostructured energy storage devices<sup>155</sup> to increase pseudocapacitive charge storage. 511 Selected examples of CVD polymer processing and applications are highlighted in Fig. 6. 512

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Some, but not all, CVD polymerization methods use the same chemical reaction mechanisms 514 (step growth, chain growth, and condensation reactions) that underlie the synthesis of 515 polymers in solution (Table 4)<sup>135</sup>. Low surface growth temperatures (typically in the range of -516 10°C to 140°C) favor the adsorption of the CVD reactants, and traditional isotherms 517 quantitatively describe monomer uptake on the growth surface<sup>156</sup>. Hence, knowledge of the 518 saturation pressure of a new vapour phase reactant at the growth temperature allows the 519 required CVD process conditions to be rapidly identified. This has been used for CVD growth of 520 hundreds of different homopolymers, copolymers, cross-linked organic networks, and 521 organic/inorganic films<sup>136</sup>, with. well-defined growth kinetics providing reproducible growth 522 even at sub-10 nm thickness<sup>147</sup>. Alternatively, the CVD conditions can be adjusted for rapid 523 growth to produce films > 10  $\mu$ m thick<sup>157</sup>. 524

Multiple strategies allow chemical covalent bonds to form between the substrate and the growing CVD polymer layer<sup>136</sup>. The resulting grafted interfaces greatly enhance durability. Avoiding delamination [G] allows grafted CVD polymer films to be patterned and even to survive sandblasting. Durablity is also enhanced by using crosslinked monomers, as crosslinked CVD organic networks display remarkable stability during multiple years of evaluation under physiological conditions<sup>158</sup>.

Fundamental understanding of CVD polymerization aids the scale-up to cost-effective 531 reactors >1 m in width and to economical roll-to-roll (R2R) processing<sup>136</sup>, which is specifically 532 detailed below (Scaling up for factory-level applications). Properties can be tuned and optimized 533 through the selection of the volatile reactants and systematic variation of the CVD parameters 534 such as flow rates, pressure, and growth temperatures. Preserving the fidelity of the 535 monomeric structure in the polymer film is often key to optimizing properties. For example, 536 preserving the structure of the monomer 3,4-ethylene dioxythiophene (EDOT) by oCVD can 537 produce electrical conductivity >6000 S cm<sup>-1 153</sup>. In contrast, plasma enhanced CVD does not 538 fully retain the chemical structure of EDOT and the resulting films typically have poor electrical 539 conductivity of <1 S cm<sup>-1 152</sup>. 540

#### [H2] Scaling up for factory-level applications

The rapid progress in CVD graphene synthesis technology means it is the first reported 2D material to be scaled up at a factory level. While we have known for more than 50 years that thin graphitic layers can be formed by CVD on nickel at high temperature using hydrocarbon sources such as methane<sup>159,160</sup>, these graphitic layers were not monolayers..owing to the high carbon solubility of nickel during the CVD process. This problem was solved by thermally

26 / 63

depositing thin layers of nickel on SiO<sub>2</sub> substrates to limit the carbon concentration, leading to 547 the formation of centimeter-scale atomically thin layer of graphene<sup>39,65,161</sup>. CVD graphene was 548 used to measure the half integer quantum Hall effect [G] originating from the ultra-high 549 mobility of charge carriers in graphene for the first time <sup>65,79</sup>, implying that the electrical 550 performance of CVD graphene can be as good as mechanically exfoliated graphene. However, 551 the non-uniform segregation of carbon sources from nickel limits the crystallinity of CVD 552 graphene; this was overcome by using copper substrates that exhibit nearly zero carbon 553 solubility, where the graphene layer is formed by the Cu-mediated gradual surface diffusion 554 and crystallization of adsorbed carbon atoms<sup>38,160</sup>. This self-limiting mechanism of graphene 555 growth immediately enabled the wafer-scale synthesis of monolayer graphene<sup>162</sup>, followed by 556 the meter-scale growth of monolayer graphene by employing continuous roll-to-roll (R2R) 557 methods<sup>163</sup>. The large-area graphene synthesized by R2R technology has been utilized for 558 practical applications such as flexible touch screens for mobile phones, flexible OLEDs, flexible 559 transparent heaters, electromagnetic wave interference (EMI) shielding films, etc.<sup>36,164-166</sup>, 560 which are expected to be commercialized in the near future. 561

R2R synthesis and its continuous processes are essential for the industrial commercialization of CVD graphene because it enables a >30-fold increase in productivity. These graphene synthesis capabilities with respect to the advances in CVD technology are highlighted in **Fig. 7a**. While plasma-assisted low-temperature growth is helpful to simplify the equipment setup and to save electrical energy, it always results in poor graphene electrical conductivity because of high defect density compared to graphene synthesized above 1,000 °C. In addition, putting multiple

copper sheets in a CVD chamber can increase synthesis capacity, but this type of batch 568 synthesis remains limited by long heating and cooling times. In the R2R system, time is not 569 wasted heating and cooling the CVD furnace; instead, the temperature in the furnace is kept 570 constant while the copper foils pass through the hot zone at a rate of ~ 50cm min<sup>-1</sup>. R2R 571 synthesis was first proposed in 2010<sup>163</sup>, while additional R2R systems employing slightly 572 different heater technologies were also developed<sup>23,35,167,168</sup>. For example, a microwave plasma 573 technique was used to lower the synthesis temperature of the R2R process<sup>35</sup>, 230 mm wide and 574 120 m long graphene films were synthesized by applying high current through copper foils 575 between the rolls<sup>167</sup>; an open chamber system was used to enable the R2R synthesis of 576 graphene <sup>169</sup>; a concentric CVD reactor was used for high-speed R2R manufacturing of graphene 577 films <sup>170</sup>; and the 190 mm-wide vertical R2R system with rapid-thermal heaters enabled faster 578 and more homogeneous heating<sup>171</sup>. More recently, the development of 500 mm wide R2R 579 systems capable of synthesizing graphene on ~100 meters long Cu foils at the rate of ~500 580  $mm \cdot min^{-1}$  was reported<sup>172</sup>. 581

The R2R method allows for the application of vertical tension to single-crystallize the Cu foils and achieve higher quality graphene films. It is also applicable to post-CVD processes including etching and lamination (**Fig. 7b**), which are limited with batch-type CVD synthesis. R2R CVD synthesis is therefore considered the best way to mass-produce the CVD graphene films for commercial applications.

Although the scale-up for 2D materials synthesis is more complicated because it requires multiple precursors in different phases, various CVD methods used for graphene synthesis have

been applied to the synthesis of other 2D materials. In general, powder sources are not 589 favorable for factory level synthesis of 2D materials because of the severe contamination of 590 reaction chambers by residual solids. Compared to conventional CVD methods using liquid or 591 solid precursors<sup>122,124</sup>, MOCVD is anticipated to be the best route to synthesize high-592 performance 2D materials larger than wafer scale<sup>173</sup>. The R2R CVD method has demonstrated 593 the synthesis of MoS<sub>2</sub> films<sup>174</sup> as well as the synthesis of *h*BN film on metal foils<sup>175</sup>. Atomic layer 594 deposition also appears as advantageous for the wafer-scale synthesis of high-mobility MoS<sub>2</sub> for 595 practical applications<sup>176</sup>. 596

Since the CVD process is only one aspect of the full fabrication process to prepare graphene on 597 target substrates, the post-CVD processes including etching and transfer need to be equally 598 considered for factory level scale-up. For example, the continuous synthesis of graphene by R2R 599 methods must be followed by the R2R lamination of polymer supports<sup>163</sup>, R2R removal of 600 copper foils by chemical etchant or electrochemical etching<sup>175</sup>, and the patterning/transfer to 601 target substrates<sup>177</sup>. The full R2R synthesis system is illustrated in **Fig. 8**. 602

#### [H1] Reproducibility and data deposition 603

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The reproducibility and reliability of the performance of materials synthesized by CVD depends 605 on both the pre-treatment and post-CVD processes. 606

With respect to the pre-treatment of substrates, we shall take as an example copper foils 607 produced for general purposes. They are usually coated with an anti-oxidizing layer such as a 608 type of chrome oxide, which needs to be removed by acid or thermal treatment<sup>36</sup> before 609

graphene synthesis. In addition, these copper foils have usually been prepared by roll-pressing 610 and are polycrystalline; they must be recrystallized to obtain larger single-crystalline graphene 611 domains during deposition, as this is one of the crucial parameters minimizing defects and 612 maximizing electrical conductivity. One approach is to mechanically strain the Cu foil during 613 CVD to transform polycrystalline copper to copper with very large single crystal domains <sup>178</sup>. 614 Since the graphene and Cu surfaces affect each other during growth, this causes the graphene-615 covered region in Cu to undergo a drastic change in crystallinity<sup>178</sup>. An alternative approach is to 616 prepare single-crystalline metal substrates by thermal annealing<sup>179</sup>, an example of which is an 617 annealed monocrystalline Cu (110) substrate used to synthesize highly crystalline large-area h-618 BN<sup>130</sup>. Another example is molten gold, which at high temperature catalyzes the CVD growth of 619 single-crystalline h-BN, and where the small h-BN domains floating on the gold surface are 620 rotated by electrostatic interaction to commensurate each other to form a wafer-scale single 621 crystalline film <sup>180</sup>. 622

The uniformity of 2D materials synthesized by CVD generally depend on the uniformity of 623 temperature and gas flow inside the reaction chamber<sup>36</sup>. For example, in the case of graphene 624 synthesized by rapid thermal CVD, the temperature uniformity can be enhanced by using multi-625 zone rapid thermal heaters, where more than 8 zones are separately controlled to balance the 626 temperature distribution (Fig. 9a). The use of graphite susceptors that convert optical radiation 627 to thermal energy is also useful to narrow down the temperature distribution. Most 628 importantly, automated control to exclude human error is the key to reproducibility (see the 629 less than 10% deviation of the graphene films sheet resistances from 10 different batches in 630 Fig.9b and their uniformity in Fig 9c, satisfying industrial requirements). The durability of the 631 30 / 63

electrical properties tested for industrial standard (85% humidity at 85 °C) was measured to be
 suitable for practical applications (Fig. 9d).

As mentioned above, the CVD synthesis step is just one aspect of the full fabrication process, 634 so the post-CVD processes including etching and transfer are as important as the CVD process 635 to ensure reliability. In particular, the doping of graphene can increase the charge carrier 636 density and considerably lower sheet resistance, which is desirable for practical applications<sup>181</sup>. 637 In practice, the inhomogeneity and volatility of doping causes a reproducibility problem. The 638 elemental doping of graphene that replaces carbon atoms with boron or nitrogen atoms is very 639 stable and homogeneous, but it lowers charge carrier mobility due to electron scattering 640 around the heteroatoms<sup>182</sup> and decreases electrical conductivity, which is undesirable. In 641 addition, while the non-destructive doping of graphene can be efficiently carried out by 642 molecular dopants and self-assembled monolayers<sup>183-185</sup>, it does not last long without proper 643 encapsulation<sup>186-188</sup>. 644

In summary, the reproducibility and reliability of the CVD-synthesized 2D materials largely depends on the surface freshness and the crystallinity of the catalytic substrates as well as the spatial uniformity of gas concentration and temperature, which need be considered in designing CVD reactors.

## [H1] Limitations and optimizations

The limitation of CVD technology often comes from the need for high temperature and high vacuum, particularly for graphene and h-BN synthesis. The most common chamber materials are quartz tubes that are thermally and mechanically strong enough to resist the reaction

conditions. As the quartz reactors are scalable only up to 12-inch (~30 cm) diameters, stainless-653 steel chambers are alternatively used to design industrial scale CVD reactors, where advanced 654 chiller systems are essential to cool down the hot chamber and its housing. A quartz reactor is 655 advantageous because it is standardized and replaceable at relatively low cost whenever the 656 reactor is heavily contaminated. In contrast, a stainless steel reactor needs to be cleaned 657 periodically to keep the quality of synthesis. The growth of other 2D materials at mild 658 temperatures does not require quartz materials, but serious contamination of reaction 659 chambers is often caused by residual precursors. Thus, the use of replaceable quartz tubes and 660 gaseous precursors is recommended for 2D materials synthesis for industrial applications. In 661 addition, a plasma module can be combined to thermal CVD systems to lower the synthesis 662 temperature<sup>189</sup>, but the high plasma energy often causes undesirable defects in the case of 663 graphene. 664

The weight of copper foils needs to be considered in the design of the R2R synthesis system. The copper foil at ~1,000 °C becomes less stiff and more ductile, so the horizontal tension across the 2~3 meters long rolls results in serious deformation. This can be minimized by vertical loading parallel to the gravitational force and winding tension<sup>178</sup>. In addition, the vertical tension control is useful to promote the growth of single-crystalline Cu foils for highquality graphene synthesis<sup>178</sup>.

To facilitate the optimization processes of CVD synthesis, high-throughput *in-situ* quality assessment tools for graphene and 2D materials are of great importance. As CVD often involves high temperatures and vacuum conditions, *in-situ* monitoring is possible only by an optical

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method equipped with fiber and lens optics that can collect signals through the optical window 674 of CVD chambers. For this reason, Raman spectroscopy has been investigated as a 675 characterization tool to examine the number of layers, defect density, and coverage of 676 graphene and 2D materials<sup>101</sup>. However, its field of view and scanning speed are not large and 677 fast enough for factory-level real-time assessment, respectively. Wide-field Raman 678 spectroscopy that scans only D and G peak ranges is much faster, but it requires extremely 679 powerful laser sources incompatible with commercial instrumentation<sup>190</sup>. Microwave 680 spectroscopy using eddy current<sup>191</sup> and terahertz time-domain spectroscopy<sup>192</sup> have enabled 681 the fast analysis of wafer scale graphene, but these methods are valid only for post-CVD 682 graphene transferred to insulating substrates. In terms of industrial quality control, the 683 evaluation of graphene as grown on copper foil is more important to optimize the growth 684 conditions. Confocal laser scanning microscopy (CLSM) is expected to satisfy the above-685 mentioned demands for real-time assessment regardless of production scale<sup>193</sup>. The CLSM 686 image contrast between graphene and copper substrate is found to be inversely proportional to 687 defect density, and therefore, the electrical conductivity can be briefly monitored by fast 688 scanning by CLSM (Fig. 10)<sup>171</sup>. It can be also applied to the quality assessment of other 2D 689 materials, although the laser wavelengths of CLSM need to be optimized on a case-by-case 690 basis. 691

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## [H1] Outlook

CVD reactors require relatively inexpensive components and are simple to set up, which has 694 led to their widespread use in the academic community for easily producing novel materials 695 such as graphene, 2D semiconductors and polymer thin films. However, CVD itself is a mature 696 commercial technology for applying thin films on variety of components and is particularly 697 useful in the electronics industry, where large area and continuous deposition of thin films can 698 be performed in specially designed reactors. Examples of these include vertical reactors for 699 floating catalytic synthesis of carbon nanotubes<sup>194,195</sup> or R2R CVD systems for graphene 700 growth<sup>178</sup>. The fundamental limitation of CVD is that it often requires high temperature 701 (typically >400  $^{\circ}$ C) to crack the precursors into reactive products that can readily form thin films 702 (especially for graphene and hBN). Lower deposition temperatures can be achieved by utilising 703 plasma to produce excited state or ionised precursors that can react at low temperatures. The 704 ability to deposit high quality films at low temperatures (typically <400 °C) is highly desirable in 705 back-end-of-the-line processes for electronics, thermosensitive substrates, and soft metals. The 706 critical challenges that remain in low temperature CVD for growing inorganic materials are lack 707 of crystallinity, trapped precursors, and maintenance of the desired stoichiometry. 708

CVD is the most widely used method for large area synthesis of advanced low-dimensional materials such as nanowires, nanotubes, and more recently two-dimensional materials, and is exclusively used for large area synthesis of graphene. While very high-quality graphene films can now be achieved over meter scales using CVD, a remaining challenge is that the growth is limited to copper (or its alloy). This is a challenge because in order to use graphene for

electronics, optics and other applications, it must be transferred onto a desired substrate. A 714 substantial amount of research has been devoted to clean transfer of graphene from copper 715 onto arbitrary substrates. This research has led to substantial progress and demonstrations that 716 high quality graphene can be transferred onto virtually any substrate. However, the risk of tears 717 and wrinkles along with incorporation of copper or transfer solvent impurities remain. Thus, 718 research in contamination and damage free transfer must continue. The ultimate achievement 719 for CVD of graphene would be the development of a process that allows direct growth of 720 graphene on any substrate. In particular, the direct, large area and local growth of graphene on 721 722 insulating wafers used in electronics would be a major breakthrough.

The research in 2D semiconductors – in particular TMDs – has clearly shown that they hold 723 tremendous promise for electronics and other applications. A major bottleneck for their 724 implementation is that the absence of a CVD process that allows the realisation of high-quality 725 large area (for example, wafer scale) thin films. The advantage of TMD films – in contrast to 726 graphene growth - is that they can be directly grown on insulating substrates but centimetre-727 scale single crystal (or even large grained) thin films are still challenging. MOCVD has shown 728 promise in achieving uniform wafer-scale atomically thin films of semiconducting 2D materials 729 such as MoS<sub>2</sub> and WS<sub>2</sub> with nanoscale domain sizes, but additional work is needed to increase 730 the size of the crystals in the atomically thin films and minimise the concentration of grain 731 boundaries. Uniform growth of single crystal 2D thin films therefore requires knowledge of the 732 nucleation and growth mechanisms that must be established through detailed analyses of the 733 reactive gas phase, surface phenomena, and measurements during MOCVD growth. In addition 734
to semiconducting 2D materials, metallic compounds (such as NbS<sub>2</sub> and VS<sub>2</sub>) are interesting from both fundamental and technological viewpoints, because high quality metallic 2D compounds synthesized via MOCVD could hold promise for high-performance contacts and interconnects. Another interesting direction of research in 2D semiconductors is the integration of different materials by stacking. To exploit the optoelectronic properties of vertically stacked heterostructures, different TMD layers must be grown on each other. Some preliminary results suggest that this is possible but more work is needed to realise wafer scale stacked 2D layers.

A fundamental problem that is rarely discussed in CVD of 2D semiconductors – in particular 742 TMDs – is that high-temperature deposition and subsequent cooling leads to by-products of 743 chalcogen (S, Se, Te) species (for example, sub-stoichiometric compounds). Decreasing the 744 temperature compromises the crystalline quality of the TMD films. Thus, development of 745 deposition and cooling processes are required to ensure that the deposited atomically thin 746 films are indeed stoichiometric. Finally, the dearth of MOCVD precursors means that only a 747 handful of 2D semiconductor compounds can be grown. This means that many interesting TMD 748 compounds - in particular metallic ones - cannot currently be deposited by MOCVD. Efforts to 749 expand the number and type of precursors will benefit the growth community in realising new 750 compounds as well as perfecting the growth of existing capabilities. A challenge with MOCVD is 751 that the precursors are toxic and thus specialized spaces with appropriate safety precautions 752 are needed to carry out the experiments. Development of benign precursors could also lead to 753 more widespread adoption of MOCVD and accelerate the development of 2D thin films. 754

36 / 63

To summarize, the key challenges to be addressed in CVD of 2D materials are: lowering the deposition temperature; uniform and large area growth on a variety of substrates; and developing benign precursors for MOCVD growth of a wide range of TMD materials.

In this Primer, we have presented a comprehensive overview of CVD methods. We have included the instrument construction and the process of material preparation and characterization, concentrating on the growth of graphene and other 2D materials such as TMDs and polymeric thin films. The recent advances and challenges of this technique in terms of mass-production, controllability, reproducibility, cost and online-monitoring have also been highlighted, in the hope of underscoring the importance and benefit CVD can bring to modern industry.

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# 767 References:

1. Teal, G. K., Fisher, J. R. & Treptow, A. W. A New Bridge Photo - Cell Employing a Photo - Conductive 768 Effect in Silicon. Some Properties of High Purity Silicon. Journal of Applied Physics 17, 879-886 (1946). 769 2. Carlson, D. E. & Wronski, C. R. Amorphous silicon solar cell. Appl Phys Lett 28, 671-673 (1976). 770 Knights, J. C. Substitutional doping in amorphous silicon. American Institute of Physics Conference Series 771 3. 772 31, 296-300 (1976). 4. Manasevit, H. M. Recollections and reflections of MO-CVD. Journal of Crystal Growth 55, 1-9 (1981). 773 5. Tsang, W. T. Chemical beam epitaxy of InP and GaAs. Appl Phys Lett 45, 1234-1236 (1984). 774 6. Xia, Y. et al. One-Dimensional Nanostructures: Synthesis, Characterization, and Applications. Advanced 775 Materials 15, 353-389 (2003). 776 Novoselov, K. S. et al. Electric field effect in atomically thin carbon films. Science 306, 666-669 (2004). 7. 777 Novoselov, K. S. et al. A roadmap for graphene. Nature 490, 192-200 (2012). 8. 778 Lin, L., Deng, B., Sun, J., Peng, H. & Liu, Z. Bridging the Gap between Reality and Ideal in Chemical 9. 779 Vapor Deposition Growth of Graphene. Chem Rev 118, 9281-9343 (2018). 780 This review provides a systematic introduction to the CVD growth of graphene. 781 Choy, K. L. Chemical vapour deposition of coatings. Progress in Materials Science 48, 57-170 (2003). 10. 782 11. Yan, K., Fu, L., Peng, H. L. & Liu, Z. F. Designed CVD Growth of Graphene via Process Engineering. 783 Accounts Chem Res 46, 2263-2274 (2013). 784 12. Wang, H. et al. Primary Nucleation-Dominated Chemical Vapor Deposition Growth for Uniform Graphene 785 786 Monolayers on Dielectric Substrate. J Am Chem Soc 141, 11004-11008 (2019). 13. Xie, H. et al. H2 O-Etchant-Promoted Synthesis of High-Quality Graphene on Glass and Its Application in 787 788 See-Through Thermochromic Displays. Small 16, e1905485 (2020). 14. Park, J. H. et al. Large-Area Monolayer Hexagonal Boron Nitride on Pt Foil. ACS Nano 8, 8520-8528 789 (2014). 790 15. Zhang, Z. W. et al. Robust epitaxial growth of two-dimensional heterostructures, multiheterostructures, and 791 superlattices. Science 357, 788-+ (2017). 792 Sahoo, P. K., Memaran, S., Xin, Y., Balicas, L. & Gutierrez, H. R. One-pot growth of two-dimensional 16. 793 lateral heterostructures via sequential edge-epitaxy. Nature 553, 63-67 (2018). 794 17. Ji, Q. et al. Epitaxial monolayer MoS2 on mica with novel photoluminescence. Nano Lett 13, 3870-3877 795 796 (2013).Zhang, Y. et al. Controlled Growth of High-Quality Monolayer WS2 Layers on Sapphire and Imaging Its 797 18. Grain Boundary. ACS Nano 7, 8963-8971 (2013). 798 Wu, J. et al. Controlled Synthesis of High-Mobility Atomically Thin Bismuth Oxyselenide Crystals. Nano 19. 799 Lett 17, 3021-3026 (2017). 800 20. Jia, K. C. et al. Copper-Containing Carbon Feedstock for Growing Superclean Graphene. J. Am. Chem. Soc. 801 141, 7670-7674 (2019). 802 803 21. Wang, H. et al. Synthesis of boron-doped graphene monolayers using the sole solid feedstock by chemical vapor deposition. Small 9, 1316-1320 (2013). 804 Jiang, B. et al. Batch synthesis of transfer-free graphene with wafer-scale uniformity. Nano Research 805 22. (2020).806 23. Deng, B. et al. Roll-to-Roll Encapsulation of Metal Nanowires between Graphene and Plastic Substrate for 807 High-Performance Flexible Transparent Electrodes. Nano Lett 15, 4206-4213 (2015). 808 25. Deng, B. et al. Scalable and ultrafast epitaxial growth of single-crystal graphene wafers for electrically 809 tunable liquid-crystal microlens arrays. Science Bulletin 64, 659-668 (2019). 810 26. Tang, L. et al. Vertical Chemical Vapor Deposition Growth of Highly Uniform 2D Transition Metal 811 Dichalcogenides. ACS Nano (2020). 812 27. Xu, J. et al. Fast Batch Production of High-Quality Graphene Films in a Sealed Thermal Molecular 813 Movement System. Small 13, 1700651 (2017). 814 28. Li, Y. et al. Large Single-Crystal Cu Foils with High-Index Facets by Strain-Engineered Anomalous Grain 815 816 Growth. Adv Mater, e2002034 (2020). 817 29. Deng, B., Liu, Z. & Peng, H. Toward Mass Production of CVD Graphene Films. Adv Mater, e1800996 818 (2018).819 30. Chen, X. D. et al. Fast Growth and Broad Applications of 25-Inch Uniform Graphene Glass. Adv Mater 29 (2017). 820

823 32. Xu, Y. & Yan, X.-T. Chemical Vapour Deposition An Integrated Engineering Design for Advanced Materials. (Springer, 2010). 824 Bointon, T. H., Barnes, M. D., Russo, S. & Craciun, M. F. High Quality Monolayer Graphene Synthesized 33. 825 by Resistive Heating Cold Wall Chemical Vapor Deposition. Advanced Materials 27, 4200-4206 (2015). 826 Qi, Y. et al. Switching Vertical to Horizontal Graphene Growth Using Faraday Cage-Assisted PECVD 34. 827 Approach for High-Performance Transparent Heating Device. Adv Mater **30** (2018). 828 35. Yamada, T., Ishihara, M., Kim, J., Hasegawa, M. & Iijima, S. A roll-to-roll microwave plasma chemical 829 vapor deposition process for the production of 294mm width graphene films at low temperature. Carbon 50, 830 2615-2619 (2012). 831 Ryu, J. et al. Fast Synthesis of High-Performance Graphene Films by Hydrogen-Free Rapid Thermal 36. 832 Chemical Vapor Deposition. ACS Nano 8, 950-956 (2014). 833 37. Piner, R. et al. Graphene Synthesis via Magnetic Inductive Heating of Copper Substrates. ACS Nano 7, 834 7495-7499 (2013). 835 Li, X. et al. Large-Area Synthesis of High-Quality and Uniform Graphene Films on Copper Foils. Science 836 38. 837 324, 1312 (2009). This is the first report of large-area monolayer graphene films via CVD. 838 Reina, A. et al. Large Area, Few-Layer Graphene Films on Arbitrary Substrates by Chemical Vapor 839 39. Deposition. Nano Lett 9, 30-35 (2009). 840 Chen, J. et al. Oxygen-aided synthesis of polycrystalline graphene on silicon dioxide substrates. J Am 40. 841 Chem Soc 133, 17548-17551 (2011). 842 41. Chen, Z. et al. High-Brightness Blue Light-Emitting Diodes Enabled by a Directly Grown Graphene Buffer 843 Layer. Adv Mater 30, e1801608 (2018). 844 Chen, Z., Qi, Y., Chen, X., Zhang, Y. & Liu, Z. Direct CVD Growth of Graphene on Traditional Glass: 42. 845 Methods and Mechanisms. Adv Mater 31, e1803639 (2019). 846 Hao, Y. F. et al. The Role of Surface Oxygen in the Growth of Large Single-Crystal Graphene on Copper. 847 43. 848 Science 342, 720-723 (2013). 849 44. Sun, L. et al. Visualizing fast growth of large single-crystalline graphene by tunable isotopic carbon source. 850 Nano Res. 10, 355-363 (2016). 45. Xu, X. et al. Ultrafast epitaxial growth of metre-sized single-crystal graphene on industrial Cu foil. Science 851 Bulletin 62, 1074-1080 (2017). 852 This report highlights the transformation of polycrystalline metal foil to a single-crystal one for high-853 quality graphene growth. 854 Wu, M. et al. Seeded growth of large single-crystal copper foils with high-index facets. Nature 581, 406-46. 855 410 (2020). 856 Li, Y., Sun, L., Liu, H., Wang, Y. & Liu, Z. Preparation of single-crystal metal substrates for growth of 47. 857 high-quality two-dimensional materials. Inorg. Chem. Front., 10.1039/D1030QI00923G (2020). 858 German, E. D. & Sheintuch, M. Predicting CH4 Dissociation Kinetics on Metals: Trends, Sticking 48. 859 Coefficients, H Tunneling, and Kinetic Isotope Effect. J Phys Chem C 117, 22811-22826 (2013). 860 49. Li, X. S. et al. Graphene Films with Large Domain Size by a Two-Step Chemical Vapor Deposition 861 862 Process. Nano Lett. 10, 4328-4334 (2010). 863 50. Bhaviripudi, S., Jia, X., Dresselhaus, M. S. & Kong, J. Role of kinetic factors in chemical vapor deposition synthesis of uniform large area graphene using copper catalyst. Nano Lett 10, 4128-4133 (2010). 864 51. Lin, L. et al. Towards super-clean graphene. Nat Commun 10, 1912 (2019). 865 52. Sun, J. et al. Direct Chemical Vapor Deposition-Derived Graphene Glasses Targeting Wide Ranged 866 Applications. Nano Lett 15, 5846-5854 (2015). 867 Li, X. S., Cai, W. W., Colombo, L. & Ruoff, R. S. Evolution of Graphene Growth on Ni and Cu by Carbon 53. 868 Isotope Labeling. Nano Lett. 9, 4268-4272 (2009). 869 Dai, B. et al. Rational design of a binary metal alloy for chemical vapour deposition growth of uniform 54. 870 single-laver graphene. Nat Commun 2, 522 (2011). 871 Liu, X. et al. Segregation Growth of Graphene on Cu-Ni Alloy for Precise Layer Control. The Journal of 55. 872 Physical Chemistry C 115, 11976-11982 (2011). 873 Liu, N. et al. The origin of wrinkles on transferred graphene. Nano Research 4, 996-1004 (2011). 874 56.

Sun, Z. Z. et al. Large-Area Bernal-Stacked Bi-, Tr-, and Tetralayer Graphene. ACS Nano 6, 9790-9796

31.

(2012).

57. Deng, B. et al. Wrinkle-Free Single-Crystal Graphene Wafer Grown on Strain-Engineered Substrates. ACS 875 876 Nano 11, 12337-12345 (2017). 877 58. Zhang, C., Fu, L., Zhang, Y. & Liu, Z. Segregation Phenomenon and Its Control in the Catalytic Growth of Graphene. Acta Chimica Sinica 71, 308-308 (2013). 878 Deng, B. et al. Anisotropic Strain Relaxation of Graphene by Corrugation on Copper Crystal Surfaces. 59. 879 Small 14, e1800725 (2018). 880 Massalski, T. B., Murray, J. L., Bennet, L. H. & Baker, H. Binary alloy phase diagrams. (ASM 60. 881 International, 1986). 882 61. Dwight E. Gray, A. I. o. P. American Institute of Physics Handbook. Third edit edn, (Mcgraw-Hill Book 883 Company, 1972). 884 62. Reina, A. et al. Growth of Large-Area Single- and Bi-Layer Graphene by Controlled Carbon Precipitation 885 on Polycrystalline Ni Surfaces. Nano Res. 2, 509-516 (2009). 886 Yan, K. et al. Modulation-doped growth of mosaic graphene with single-crystalline p-n junctions for 63. 887 efficient photocurrent generation. Nat Commun 3, 1280 (2012). 888 64. Blake, P. et al. Making graphene visible. Appl Phys Lett 91, 063124 (2007). 889 890 65. Kim, K. S. et al. Large-scale pattern growth of graphene films for stretchable transparent electrodes. Nature 891 457, 706-710 (2009). 892 66. Huang, M. et al. Large-area single-crystal AB-bilayer and ABA-trilayer graphene grown on a Cu/Ni(111) foil. Nat Nanotechnol 15, 289-295 (2020). 893 67. Gao, L. B. et al. Repeated growth and bubbling transfer of graphene with millimetre-size single-crystal 894 grains using platinum. Nat Commun 3, 699 (2012). 895 Duong, D. L. et al. Probing graphene grain boundaries with optical microscopy. Nature 490, 235-239 69. 896 (2012). 897 70. Gan, L. & Luo, Z. T. Turning off Hydrogen To Realize Seeded Growth of Subcentimeter Single-Crystal 898 Graphene Grains on Copper. ACS Nano 7, 9480-9488 (2013). 899 71. Ly, T. H. et al. Nondestructive Characterization of Graphene Defects. Adv Funct Mater 23, 5183-5189 900 (2013).901 72. Kong, X. H. et al. Non-destructive and rapid evaluation of chemical vapor deposition graphene by dark 902 field optical microscopy. Appl Phys Lett 103, 043119 (2013). 903 73. Huang, L. et al. Twinkling graphene on polycrystalline Cu substrate: A scanning electron microscopy study. 904 Journal of Applied Physics 125 (2019). 905 Huang, L. et al. High-Contrast SEM Imaging of Supported Few-Layer Graphene for Differentiating 74. 906 907 Distinct Layers and Resolving Fine Features: There is Plenty of Room at the Bottom. Small 14, e1704190 (2018).908 75. Wang, Z. J. et al. Direct Observation of Graphene Growth and Associated Copper Substrate Dynamics by 909 in Situ Scanning Electron Microscopy. ACS Nano 9, 1506-1519 (2015). 910 Lee, C., Wei, X. D., Kysar, J. W. & Hone, J. Measurement of the elastic properties and intrinsic strength of 76. 911 monolayer graphene. Science 321, 385-388 (2008). 912 Sun, L. et al. A Force-Engineered Lint Roller for Superclean Graphene. Adv Mater 31, 1902978 (2019). 77. 913 Kang, J. H. et al. Strain Relaxation of Graphene Layers by Cu Surface Roughening. Nano Lett 16, 5993-914 78. 5998 (2016). 915 79. Bae, S. et al. Roll-to-roll production of 30-inch graphene films for transparent electrodes. Nat Nanotechnol 916 5, 574-578 (2010). 917 This report highlights the large-scale growth and transfer of graphene films. 918 Yu, Q. K. et al. Control and characterization of individual grains and grain boundaries in graphene grown 919 80. by chemical vapour deposition. Nat Mater 10, 443-449 (2011). 920 921 81. Levy, N. et al. Strain-Induced Pseudo-Magnetic Fields Greater Than 300 Tesla in Graphene Nanobubbles. Science 329, 544-547 (2010). 922 82. Lahiri, J., Lin, Y., Bozkurt, P., Oleynik, I. I. & Batzill, M. An extended defect in graphene as a metallic 923 924 wire. Nat Nanotechnol 5, 326-329 (2010). Artyukhov, V. I., Liu, Y. Y. & Yakobson, B. I. Equilibrium at the edge and atomistic mechanisms of 925 83. graphene growth. P Natl Acad Sci USA 109, 15136-15140 (2012). 926 84. Shu, H. B., Chen, X. S., Tao, X. M. & Ding, F. Edge Structural Stability and Kinetics of Graphene 927 Chemical Vapor Deposition Growth. ACS Nano 6, 3243-3250 (2012). 928

- 85. Yuan, Q. H. *et al.* Magic Carbon Clusters in the Chemical Vapor Deposition Growth of Graphene. J. Am. *Chem. Soc.* 134, 2970-2975 (2012).
- 86. Rasool, H. I. *et al.* Continuity of Graphene on Polycrystalline Copper. *Nano Lett* **11**, 251-256 (2011).
- Rasool, H. I. *et al.* Atomic-Scale Characterization of Graphene Grown on Copper (100) Single Crystals. J
   Am Chem Soc 133, 12536-12543 (2011).
- 88. Yang, W. *et al.* Epitaxial growth of single-domain graphene on hexagonal boron nitride. *Nat Mater* 12, 792-797 (2013).
- 89. Liu, L. *et al.* Heteroepitaxial Growth of Two-Dimensional Hexagonal Boron Nitride Templated by
  Graphene Edges. *Science* 343, 163-167 (2014).
- 938 90. Yuan, G. W. et al. Proton-assisted growth of ultra-flat graphene films. *Nature* 577, 204-208 (2020).
- 939 91. Sutter, E., Acharya, D. P., Sadowski, J. T. & Sutter, P. Scanning tunneling microscopy on epitaxial bilayer
  940 graphene on ruthenium (0001). *Appl Phys Lett* 94, 133101 (2009).
- 941 92. Gao, L., Guest, J. R. & Guisinger, N. P. Epitaxial Graphene on Cu(111). Nano Lett 10, 3512-3516 (2010).
- 942 93. Hashimoto, A., Suenaga, K., Gloter, A., Urita, K. & Iijima, S. Direct evidence for atomic defects in graphene layers. *Nature* 430, 870-873 (2004).
- 944 94. Huang, P. Y. *et al.* Grains and grain boundaries in single-layer graphene atomic patchwork quilts. *Nature*945 469, 389-392 (2011).
- 946 95. Kim, K. et al. Grain Boundary Mapping in Polycrystalline Graphene. ACS Nano 5, 2142-2146 (2011).
- 947 96. Lee, J. H. *et al.* Wafer-Scale Growth of Single-Crystal Monolayer Graphene on Reusable Hydrogen948 Terminated Germanium. *Science* 344, 286-289 (2014).
- 949 97. Jiang, Y. *et al.* Electron ptychography of 2D materials to deep sub-angstrom resolution. *Nature* 559, 343950 349 (2018).
- 951 98. Chen, T. A. *et al.* Wafer-scale single-crystal hexagonal boron nitride monolayers on Cu (111). *Nature* 579, 219-223 (2020).
- 100. Xu, X. Z. *et al.* Ultrafast growth of single-crystal graphene assisted by a continuous oxygen supply. *Nat Nanotechnol* 11, 930-935 (2016).
- Ferrari, A. C. & Basko, D. M. Raman spectroscopy as a versatile tool for studying the properties of graphene. *Nat Nanotechnol* 8, 235-246 (2013).

#### <sup>957</sup> This paper highlights the utility of Raman spectroscopy for characterizing the properties of graphene.8

- 102. Ferrari, A. C. *et al.* Raman spectrum of graphene and graphene layers. *Phys Rev Lett* **97**, 187401 (2006).
- Das, A. *et al.* Monitoring dopants by Raman scattering in an electrochemically top-gated graphene transistor. *Nat Nanotechnol* 3, 210-215 (2008).
- 104. Lee, J. E., Ahn, G., Shim, J., Lee, Y. S. & Ryu, S. Optical separation of mechanical strain from charge doping in graphene. *Nat Commun* 3, 1024 (2012).
- Bronsgeest, M. S. *et al.* Strain Relaxation in CVD Graphene: Wrinkling with Shear Lag. *Nano Lett* 15, 5098-5104 (2015).
- I06. Zhao, T. *et al.* Ultrafast growth of nanocrystalline graphene films by quenching and grain-size-dependent strength and bandgap opening. *Nat Commun* 10, 4854 (2019).
- 967 107. Varykhalov, A. *et al.* Electronic and Magnetic Properties of Quasifreestanding Graphene on Ni. *Phys Rev* 968 *Lett* 101, 157601 (2008).
- Avila, J. *et al.* Exploring electronic structure of one-atom thick polycrystalline graphene films: A nano angle resolved photoemission study. *Sci Rep-Uk* **3**, 2439 (2013).
- 109. Varykhalov, A., Scholz, M. R., Kim, T. K. & Rader, O. Effect of noble-metal contacts on doping and band gap of graphene. *Phys Rev B* 82, 121101 (2010).
- 973 110. Gottardi, S. *et al.* Comparing Graphene Growth on Cu(111) versus Oxidized Cu(111). *Nano Lett* 15, 917 974 922 (2015).
- Bakharev, P. V. *et al.* Chemically induced transformation of chemical vapour deposition grown bilayer
  graphene into fluorinated single-layer diamond. *Nat Nanotechnol* 15, 59-66 (2020).
- 277 112. Zhan, Y., Liu, Z., Najmaei, S., Ajayan, P. M. & Lou, J. Large-Area Vapor-Phase Growth and 278 Characterization of MoS2 Atomic Layers on a SiO2 Substrate. *Small* 8, 966-971 (2012).
- P79 113. Chhowalla, M., Liu, Z. & Zhang, H. Two-dimensional transition metal dichalcogenide (TMD) nanosheets.
   *Chemical Society Reviews* 44, 2584-2586 (2015).

#### 981 This review article introduces two-dimensional transition metal dichalcogenides.

114. Lv, R. *et al.* Transition Metal Dichalcogenides and Beyond: Synthesis, Properties, and Applications of Single- and Few-Layer Nanosheets. *Accounts of Chemical Research* 48, 56-64 (2015).

- 115. Liu, K.-K. *et al.* Growth of Large-Area and Highly Crystalline MoS2 Thin Layers on Insulating Substrates.
   *Nano Lett* 12, 1538-1544 (2012).
- Wang, X. *et al.* Chemical Vapor Deposition Growth of Crystalline Monolayer MoSe2. *ACS Nano* 8, 5125-5131 (2014).
- Huang, C. *et al.* Lateral heterojunctions within monolayer MoSe2–WSe2 semiconductors. *Nat Mater* 13, 1096-1101 (2014).
- Liu, B. *et al.* Chemical Vapor Deposition Growth of Monolayer WSe2 with Tunable Device Characteristics and Growth Mechanism Study. *ACS Nano* 9, 6119-6127 (2015).
- Li, S. *et al.* Halide-assisted atmospheric pressure growth of large WSe2 and WS2 monolayer crystals.
   *Applied Materials Today* 1, 60-66 (2015).
- Li, G. *et al.* Direct Growth of Continuous and Uniform MoS2 Film on SiO2/Si Substrate Catalyzed by Sodium Sulfate. *The Journal of Physical Chemistry Letters* 11, 1570-1577 (2020).
- Yang, P. *et al.* Batch production of 6-inch uniform monolayer molybdenum disulfide catalyzed by sodium in glass. *Nat Commun* 9, 979 (2018).
- 122. Lee, Y.-H. *et al.* Synthesis of Large-Area MoS2 Atomic Layers with Chemical Vapor Deposition.
   Advanced Materials 24, 2320-2325 (2012).
- 1000 123. Dumcenco, D. et al. Large-Area Epitaxial Monolayer MoS2. ACS Nano 9, 4611-4620 (2015).
- 1001 124. Kang, K. *et al.* High-mobility three-atom-thick semiconducting films with wafer-scale homogeneity.
   1002 Nature 520, 656-660 (2015).
- 125. Kim, H., Ovchinnikov, D., Deiana, D., Unuchek, D. & Kis, A. Suppressing Nucleation in Metal–Organic
   Chemical Vapor Deposition of MoS2 Monolayers by Alkali Metal Halides. *Nano Lett* 17, 5056-5063 (2017).
- 1006 126. Wang, Y. *et al.* Van der Waals contacts between three-dimensional metals and two-dimensional semiconductors. *Nature* **568**, 70-74 (2019).
- 1008 127. Zhou, J. et al. A library of atomically thin metal chalcogenides. Nature 556, 355-359 (2018).
- 128. Yang, J. *et al.* Ultrahigh-current-density niobium disulfide catalysts for hydrogen evolution. *Nat Mater* 18, 1309-1314 (2019).
- 129. Behura, S., Nguyen, P., Che, S., Debbarma, R. & Berry, V. Large-Area, Transfer-Free, Oxide-Assisted
  Synthesis of Hexagonal Boron Nitride Films and Their Heterostructures with MoS2 and WS2. *J Am Chem*1013 Soc 137, 13060-13065 (2015).
- 1014 130. Wang, L. *et al.* Epitaxial growth of a 100-square-centimetre single-crystal hexagonal boron nitride 1015 monolayer on copper. *Nature* **570**, 91-95 (2019).
- 1016 131. Xu, C. *et al.* Large-area high-quality 2D ultrathin Mo2C superconducting crystals. *Nat Mater* **14**, 1135-1141 (2015).
- 132. Wang, Z. *et al.* Metal Immiscibility Route to Synthesis of Ultrathin Carbides, Borides, and Nitrides. *Adv* Mater 29 (2017).
- 133. Wu, J. *et al.* High electron mobility and quantum oscillations in non-encapsulated ultrathin semiconducting
   Bi2O2Se. *Nat Nanotechnol* (2017).
- 1022 134. Tan, C. *et al.* Wafer-Scale Growth of Single-Crystal 2D Semiconductor on Perovskite Oxides for High-1023 Performance Transistors. *Nano Lett* **19**, 2148-2153 (2019).
- 135. Gleason, K. K. CVD Polymers: Fabrication of Organic Surfaces and Devices. 1-461 (John Wiley & Sons, 2015).
- 1026 136. Gleason, K. K. Nanoscale control by chemically vapour-deposited polymers. *Nat. Rev. Phys.* **2**, 347-364 (2020).
- 1028 This review introduces the controllable growth of polymers via CVD.
- 1029 137. De Luna, M. M., Karandikar, P. & Gupta, M. Interactions between polymers and liquids during initiated 1030 chemical vapor deposition onto liquid substrates. *Mol. Syst. Des. Eng.* **5**, 15-21 (2020).
- 1031 138. Donadt, T. B. & Yang, R. Vapor-Deposited Biointerfaces and Bacteria: An Evolving Conversation. ACS
   1032 Biomaterials Science & Engineering 6, 182-197 (2020).
- 1033 139. Moni, P., Al-Obeidi, A. & Gleason, K. K. Vapor deposition routes to conformal polymer thin films.
   1034 *Beilstein Journal of Nanotechnology* 8, 723-735 (2017).
- 1035 140. Coclite, A. M. Smart surfaces by initiated chemical vapor deposition. *Surface innovations* **1**, 6-14 (2013).
- 141. Gleason, K. K. Chemically vapor deposited polymer nanolayers for rapid and controlled permeation of molecules and ions. *Journal of Vacuum Science & Technology A: Vacuum, Surfaces, and Films* 38, 020801 (2020).

142. 1039 Perrotta, A., Werzer, O. & Coclite, A. M. Strategies for Drug Encapsulation and Controlled Delivery Based on Vapor - Phase Deposited Thin Films. Advanced Engineering Materials 20, 1700639 (2018). 1040 143. Sayin, S., Ozdemir, E., Acar, E. & Ince, G. O. Multifunctional one-dimensional polymeric nanostructures 1041 for drug delivery and biosensor applications. *Nanotechnology* **30**, 412001 (2019). 1042 144. Zhao, J. & Gleason, K. K. Solvent-less vapor-phase fabrication of membranes for sustainable separation 1043 1044 processes. Engineering (2020). 145. Lewis, H. G. P., Bansal, N. P., White, A. J. & Handy, E. S. HWCVD of polymers: Commercialization and 1045 scale-up. Thin Solid Films 517, 3551-3554 (2009). 1046 Kim, S. et al. Ultrathin high-resolution flexographic printing using nanoporous stamps. Science Advances 2, 1047 146. e1601660 (2016). 1048 147. Suh, H. S. et al. Sub-10-nm patterning via directed self-assembly of block copolymer films with a vapour-1049 phase deposited topcoat. Nat Nanotechnol 12, 575 (2017). 1050 148. Moni, P. et al. Ultrathin and Conformal Initiated Chemical-Vapor-Deposited Layers of Systematically 1051 1052 Varied Surface Energy for Controlling the Directed Self-Assembly of Block CoPolymers. Langmuir 34, 1053 4494-4502 (2018). 149. Yang, G. G. et al. Conformal 3D Nanopatterning by Block Copolymer Lithography with Vapor-Phase 1054 Deposited Neutral Adlayer. ACS Nano 13, 13092-13099 (2019). 1055 150. Yu, S. J. et al. Initiated chemical vapor deposition: A versatile tool for various device applications. 1056 Advanced Engineering Materials 20, 1700622 (2018). 1057 This review article highlights the synthesis of polymers via an advanced CVD method. 1058 Kim, J. H. et al. in 2018 IEEE International Electron Devices Meeting (IEDM). 11.11. 11-11.11. 14 151. 1059 (IEEE). 1060 Gharahcheshmeh, M. H. & Gleason, K. K. Device fabrication based on oxidative chemical vapor 1061 152. deposition (oCVD) synthesis of conducting polymers and related conjugated organic materials. Advanced 1062 1063 Materials Interfaces 6, 1801564 (2019). 1064 153. Wang, X. et al. High electrical conductivity and carrier mobility in oCVD PEDOT thin films by engineered crystallization and acid treatment. Science advances 4, eaat5780 (2018). 1065 The electrical conductivity and carrier mobility of a mechanically flexible CVD organic polymer thin 1066 film reaches the levels found in mechanical brittle indium tin oxide. 1067 154. Gueve, M. N., Carella, A., Faure-Vincent, J., Demadrille, R. & Simonato, J.-P. Progress in understanding 1068 structure and transport properties of PEDOT-based materials: A critical review. Progress in Materials 1069 Science 108, 100616 (2019). 1070 155. Smolin, Y. Y., Soroush, M. & Lau, K. K. Influence of oCVD polyaniline film chemistry in carbon-based 1071 supercapacitors. Industrial & Engineering Chemistry Research 56, 6221-6228 (2017). 1072 Lau, K. K. & Gleason, K. K. Initiated chemical vapor deposition (iCVD) of poly (alkyl acrylates): an 156. 1073 experimental study. Macromolecules 39, 3688-3694 (2006). 1074 Tao, R. & Anthamatten, M. Condensation and Polymerization of Supersaturated Monomer Vapor. 157. 1075 1076 Langmuir 28, 16580-16587 (2012). 1077 158. O'Shaughnessy, W., Murthy, S., Edell, D. & Gleason, K. Stable biopassive insulation synthesized by 1078 initiated chemical vapor deposition of poly (1, 3, 5-trivinyltrimethylcyclotrisiloxane). Biomacromolecules 8, 2564-2570 (2007). 1079 159. Obraztsov, A. N., Obraztsova, E. A., Tyurnina, A. V. & Zolotukhin, A. A. Chemical vapor deposition of 1080 thin graphite films of nanometer thickness. Carbon 45, 2017-2021 (2007). 1081 Yu, Q. et al. Graphene segregated on Ni surfaces and transferred to insulators. Appl Phys Lett 93, 113103 160. 1082 (2008).1083 Lee, Y. et al. Wafer-Scale Synthesis and Transfer of Graphene Films. Nano Lett 10, 490-493 (2010). 162. 1084 163. Hong, B. H. et al. Graphene roll-to-roll coating apparatus and graphene roll-to-roll coating method using 1085 the same. United States KR1020100011437 patent (2010). 1086 164. Han, T.-H. et al. Extremely efficient flexible organic light-emitting diodes with modified graphene anode. 1087 Nature Photonics 6, 105-110 (2012). 1088 165. Kang, J. et al. High-Performance Graphene-Based Transparent Flexible Heaters. Nano Lett 11, 5154-5158 1089 1090 (2011).Kang, S. et al. Efficient heat generation in large-area graphene films by electromagnetic wave absorption. 1091 166. 2D Materials 4, 025037 (2017). 1092

- 1093 167. Kobayashi, T. *et al.* Production of a 100-m-long high-quality graphene transparent conductive film by roll-1094 to-roll chemical vapor deposition and transfer process. *Appl Phys Lett* **102**, 023112 (2013).
- 168. Hesjedal, T. Continuous roll-to-roll growth of graphene films by chemical vapor deposition. *Appl Phys Lett*98, 133106 (2011).
- 169. Zhong, G. *et al.* Growth of continuous graphene by open roll-to-roll chemical vapor deposition. *Appl Phys Lett* 109, 193103 (2016).
- 170. Polsen, E. S., McNerny, D. Q., Viswanath, B., Pattinson, S. W. & John Hart, A. High-speed roll-to-roll manufacturing of graphene using a concentric tube CVD reactor. *Sci Rep-Uk* 5, 10257 (2015).
- 171. Kim, D. J. e. a. Confocal laser scanning microscopy as a real time quality-assessment tool for industrial graphene synthesis. 2D Materials 7, 045014 (2020).
- 1103 172. Hong, B. H. Commercial Scale Production of CVD Graphene and Graphene Quantum Dots. *Phantom Foundation*, Graphene Industrial Forum 2020 (2020).
- 1105 173. Robertson, J., Liu, X., Yue, C., Escarra, M. & Wei, J. Wafer-scale synthesis of monolayer and few-layer
   1106 MoS 2 via thermal vapor sulfurization. 2D Materials 4, 045007 (2017).
- 1107 174. Lim, Y. R. *et al.* Roll-to-Roll Production of Layer-Controlled Molybdenum Disulfide: A Platform for 2D
   1108 Semiconductor-Based Industrial Applications. *Advanced Materials* 30, 1705270 (2018).
- 1109 175. Hempel, M. *et al.* Repeated roll-to-roll transfer of two-dimensional materials by electrochemical delamination. *Nanoscale* 10, 5522-5531 (2018).
- 1111 176. Jeon, W., Cho, Y., Jo, S., Ahn, J.-H. & Jeong, S.-J. Wafer-Scale Synthesis of Reliable High-Mobility Molybdenum Disulfide Thin Films via Inhibitor-Utilizing Atomic Layer Deposition. *Advanced Materials* 1113 29, 1703031 (2017).
- 1114 177. Choi, T. *et al.* Roll-to-roll continuous patterning and transfer of graphene via dispersive adhesion.
   1115 Nanoscale 7, 7138-7142 (2015).
- 1116178.Jo, I. *et al.* Tension-controlled single-crystallization of copper foils for roll-to-roll synthesis of high-quality1117graphene films. 2D Materials 5, 024002 (2018).
- In, S. *et al.* Colossal grain growth yields single-crystal metal foils by contact-free annealing. *Science* 362, 1021 (2018).
- 180. Lee, J. S. *et al.* Wafer-scale single-crystal hexagonal boron nitride film via self-collimated grain formation.
   *Science* 362, 817 (2018).
- 181. Kim, Y.-J., Kim, Y., Novoselov, K. & Hong, B. H. Engineering electrical properties of graphene: chemical approaches. 2D Materials 2, 042001 (2015).
- 1124 182. Zhao, L. *et al.* Visualizing Individual Nitrogen Dopants in Monolayer Graphene. *Science* 333, 999 (2011).
- 1125 183. Kim, Y. *et al.* Vapor-Phase Molecular Doping of Graphene for High-Performance Transparent Electrodes.
   1126 ACS Nano 8, 868-874 (2014).
- 1127184.Kim, Y. *et al.* A highly conducting graphene film with dual-side molecular n-doping. Nanoscale 6, 9545-11289549 (2014).
- 1129 185. Jo, I. *et al.* Stable n-type doping of graphene via high-molecular-weight ethylene amines. *Physical Chemistry Chemical Physics* 17, 29492-29495 (2015).
- 1131186.Yan, C. *et al.* Mechanical and Environmental Stability of Polymer Thin-Film-Coated Graphene. ACS Nano1132**6**, 2096-2103 (2012).
- 187. Choi, K. *et al.* Reduced Water Vapor Transmission Rate of Graphene Gas Barrier Films for Flexible
   Organic Field-Effect Transistors. *ACS Nano* 9, 5818-5824 (2015).
- 1135 188. Kim, D. J. *et al.* Degradation Protection of Color Dyes Encapsulated by Graphene Barrier Films. *Chemistry of Materials* 31, 7173-7177 (2019).
- 1137 189. Kim, J. *et al.* Low-temperature synthesis of large-area graphene-based transparent conductive films using
   1138 surface wave plasma chemical vapor deposition. *Appl Phys Lett* **98**, 091502 (2011).
- 1139 190. Havener, R. W. *et al.* High-Throughput Graphene Imaging on Arbitrary Substrates with Widefield Raman
  1140 Spectroscopy. *ACS Nano* 6, 373-380 (2012).
- 1141 191. Krupka, J., Strupinski, W. & Kwietniewski, N. Microwave Conductivity of Very Thin Graphene and Metal
  1142 Films. *Journal of Nanoscience and Nanotechnology* 11, 3358-3362 (2011).
- 1143 192. Whelan, P. R. *et al.* Robust mapping of electrical properties of graphene from terahertz time-domain 1144 spectroscopy with timing jitter correction. *Opt. Express* **25**, 2725-2732 (2017).
- 1145 193. Panchal, V. *et al.* Confocal laser scanning microscopy for rapid optical characterization of graphene.
   1146 *Communications Physics* 1, 83 (2018).
- 1147 194. Ci, L. *et al.* Preparation of carbon nanofibers by the floating catalyst method. *Carbon* **38**, 1933-1937 (2000).

- 148 195. Wang, B. W. *et al.* Continuous Fabrication of Meter-Scale Single-Wall Carbon Nanotube Films and their
  149 Use in Flexible and Transparent Integrated Circuits. *Adv Mater* **30**, e1802057 (2018).
- 196. Huang, J.-K. *et al.* Large-Area Synthesis of Highly Crystalline WSe2 Monolayers and Device Applications.
   *ACS Nano* 8, 923-930 (2014).
- 1152197.Geng, D. et al. Direct Synthesis of Large-Area 2D Mo2 C on In Situ Grown Graphene. Adv Mater 291153(2017).
- 1154 198. Coclite, A. M. *et al.* 25th anniversary article: CVD polymers: A new paradigm for surface modifi cation 1155 and device fabrication. *Advanced Materials* **25**, 5392-5423 (2013).
- 199. Zhou, H. & Bent, S. F. Fabrication of organic interfacial layers by molecular layer deposition: Present status and future opportunities. *Journal of Vacuum Science & Technology A: Vacuum, Surfaces, and Films*1158 **31**, 040801 (2013).
- George, S. M., Yoon, B. & Dameron, A. A. Surface Chemistry for Molecular Layer Deposition of Organic and Hybrid Organic– Inorganic Polymers. *Accounts of chemical research* 42, 498-508 (2009).
- 1161 201. Bilger, D., Homayounfar, S. Z. & Andrew, T. L. A critical review of reactive vapor deposition for conjugated polymer synthesis. *Journal of Materials Chemistry C* **7**, 7159-7174 (2019).
- 1163 202. Gharahcheshmeh, M. H. & Gleason, K. K. Engineering texture and nanostrcuture in conjugated conducting 1164 and semiconducting polymers. *Materials Today Advances* **8**, 100086 (2020).
- 203. Chen, H.-Y. & Lahann, J. Designable biointerfaces using vapor-based reactive polymers. *Langmuir* 27, 34-48 (2011).
- Hassan, Z., Spuling, E., Knoll, D. M. & Bräse, S. Regioselective functionalization of [2.2] paracyclophanes:
   Recent synthetic progress and perspectives. *Angewandte Chemie International Edition* 59, 2156-2170 (2020).
- 1170 205. Yasuda, H. K. & Plasma polymerization (Academic Press Inc, New York, 1985).
- 1171 206. Kovacik, P., del Hierro, G., Livernois, W. & Gleason, K. K. Scale-up of oCVD: large-area conductive 1172 polymer thin films for next-generation electronics. *Materials Horizons* **2**, 221-227 (2015).
- 1173207.Barr, M. C. *et al.* Direct monolithic integration of organic photovoltaic circuits on unmodified paper.1174Advanced Materials 23, 3500-3505 (2011).
- 1175 208. Lau, K. K. et al. Superhydrophobic carbon nanotube forests. Nano Lett 3, 1701-1705 (2003).
- 1176 209. Yang, S. C. *et al.* Large Scale, Low Power Nonvolatile Memory Based on Few Layer MoS2 and Ultrathin Polymer Dielectrics. *Advanced Electronic Materials* **5**, 1800688 (2019).
- 1178

1181 Highlighted review is missing:

1182 Cai, Z., Liu, B., Zou, X. & Cheng, H. M. Chemical Vapor Deposition Growth and Applications of Two-

- Dimensional Materials and Their Heterostructures. Chem Rev 118, 6091-6133 (2018). This is a
- systematic introduction to CVD growth of two-dimensional materials and their hetrostructures.

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- 1197 Competing interests
- K.K.G is a co-founder of GVD Corporation and DropWise Technologies. Both companies are
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- 1200

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# 1207 Tables

# 1208 1209

Table 1. Carbon solubility and thermal expansion properties of CVD substrates<sup>60,61</sup>

Cubatrataa	Carbon solubility at 1000 °C	Coefficient of thermal expansion		
Substrates	(at.%) <sup>60</sup>	(10 <sup>-6</sup> K <sup>-1</sup> ) <sup>61</sup>		
Graphene	-	-7		
Cu	0.04	16.7		
Ni	1.3	12.8		
Pt	1.76	8.9		
Со	3.41	13.7		
Ru	1.56	6.7		
Pd	5.98	11.6		
Ir	1.35	6.5		
SiC	-	3.5		
Si	-	2.5		
Quratz (SiO <sub>2</sub> )	-	0.4		
Sapphire (Al <sub>2</sub> O <sub>3</sub> )	-	5.0–5.6		

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**Table 2.** Characterization tools and their settings for assessing graphene quality and structure.

Assessment tool(s)	Spatial resolution	Property	Advantages	Disadvantages	Consideration s
Optical microscopy	≤µm	individual domain shapes; surface coverage; number of layers ; grain boundaries; defects (wrinkles and folds)	Simple to operate; Large-area characterizati on; non- destructive to the sample	low resolution; usually needs a suitable substrate	Clearer images when choosing a suitable wavelength of light or adding an optical filter
scanning electron microscopy	~ nm	individual domain shapes; surface coverage; number of layers ; grain boundaries; Defects (wrinkles and folds)	Simple to operate; Large-area characterizati on; High- resolution; Good environment al adaptability	damages the graphene atomic lattice	Based on electron scattering; the electron beam energy ranges from a few 100 eV to a few keV
atomic force microscopy	≤nm	individual domain shapes; surface coverage; roughness; grain boundaries; number of layers	High- resolution; Good environment al adaptability	Scanned area is small; scanning speed is slow; unsuitable for samples with significant surface topography	Sample surface must be clean. Pollutants contaminate the tip and can result in virtual and/or false images.
scanning tunneling microscopy	≤Å	Atomic structures (e.g. point defects, grain boundaries); crystal orientation	Atomic resolution; non- destructive	scanned area is small; substrate must be conductive and ultra-smooth; complex and expensive	Based on quantum tunneling effect; two possible operation modes (constant current or constant height)

transmissio n electron microscopy	≤Å	Atomic structures (e.g. point defects, grain boundaries); crystal orientation; purity	Atomic resolution; can obtain cross-section geometry	as-grown graphene must be transferred to a suitable substrate	high energy electron beam (several 10 keV to few 100 keV ) can induce defects
Raman spectrosco py	~100 nm (diffractio n limit)	number of layers; defects; strain; doping	simple to operate; High sensitivity Spatially- resolved distribution can be easily obtained by mapping the sample	qualitative only	SiO <sub>2</sub> is the most frequently used substrate
X-ray photoelectr on spectrosco py	100 µ m	purity	Surface sensitive technique to analyze elemental composition and chemical state	Low spatial resolution; no accurate quantification	Detecting depth ranges from 1 nm to 10 nm
angular resolution photoemiss ion spectrosco py	~ meV (relies on the resolution of the analyzer, the sample and the UV source)	Electronic properties (band structure); doping	band structure can be directly observed; as- grown graphene can be directly characterized	The band structure above the Fermi surface cannot be obtained; complex and expensive	Based on the photoelectric effect

**Table 3.** Summary of typical CVD methods for growing 2D materials

Materials	Substrate	Precursor 1	Precursor 2	Key parameters	Remarks	References
hBN	Cu, Ni, Pt, SiO <sub>2</sub> , Sapphire	NH <sub>3</sub> -BH <sub>3</sub> (heating at 60 ~100 °C)	-	LPCVD with H <sub>2</sub> /Ar flow, at ~1000°C	Single crystal substrate with steps can induce the mono-orientation of <i>h</i> BN	98,129,130
MS <sub>2</sub> (M=Mo, W, etc.)		S powder (heating at 100 ~ 200 °C)	MO₃ (near the hot center)	APCVD or LPCVD, with H <sub>2</sub> /Ar flow at 600 ~ 900 °C	NaCl or KCl can serve	17,127,129
SiO <sub>2</sub> , Mica	$(C_2H_5)_2S$ (0.4 sccm)		MOCVD, at ~1000 Pa, 550 °C	as promoters for improving the quality and growth	124	
MSe <sub>2</sub> (M=Mo, W, etc.)	<sup>2</sup> 2 10, .c.)	Se powder (heating at 200 ~ 300 °C)	MO₃ (near the hot center)	APCVD or LPCVD, with H <sub>2</sub> /Ar flow, at 750 °C ~850 °C	TMDs.	116,127,196
Mo₂C, TaC	Mo, Ta	$CH_{4,} C_2H_2$	-	APCVD, at ~1100 °C	Molten copper plays an important role in the catalytic growth process	131,132,197
Bi <sub>2</sub> O <sub>2</sub> Se	Mica, SrTiO₃	Bi₂Se₃ (Heating at 650~700 °C)	Bi₂O₃ (Heating at 650~700 °C)	LPCVD, with Ar/O <sub>2</sub> flow at 500 ~600 °C	Substrate with quadruple symmetry (SrTiO <sub>3</sub> ) is important for epitaxial growth of single-crystal Bi <sub>2</sub> O <sub>2</sub> Se	19,134

Table 4. Summary of CVD polymer growth methods. Typical reactants, solution-phase analogy,
 and polymer backbone structure for different CVD polymerization methods

CVD polymerization method	Typical Reactants	Analogous Solution	Structure of Polymer	References

		Mechanism	Backbone	
initiated CVD (iCVD)	initiator + monomer(s)	chain growth	carbon single bonds	142,198
molecular layer deposition (MLD)	pair of monomers	condensation	includes heteroatoms (e.g. O,N)	199,200
oxidative CVD (oCVD)	oxidant + monomer(s)	step growth	alternating single and double bonds	152,201,202
poly(p-xylylenes) (parylene)	dimer	none	hydrocarbon	203,204
plasma enhanced CVD (PECVD)	volatile precursor(s)	none	various, typically crosslinked	205

- <sup>1223</sup> Figure legends
- 1224

FIG. 1 | Schematic diagram of general elementary steps of typical CVD process. First, reactant gases 1225 (blue circles) are transported into the reactor (a). Then, there are two possible routes for the reactant 1226 gases: directly diffusing through the boundary layer (b) and adsorbing onto the substrate (c); forming 1227 intermediate reactants (green circles) and by products (red circles) via the gas-phase reaction (d) and 1228 deposited onto the substrate by diffusion (b) and adsorption (c). Surface diffusion and heterogeneous 1229 reactions (e) take place on the surface of substrate before the formation of thin films or coatings. Finally, 1230 by-products and unreacted species are desorbed from the surface and forced out of the reactor as 1231 exhausts (f). 1232

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FIG. 2 | Typical CVD equipment. a. Schematic diagram of a typical horizontal CVD system, which 1234 includes: a gas delivery system, the quartz reaction chamber, a vacuum system, the energy system and 1235 an auto-control system. b. A photograph of liquid precursor bubbler, which can also be used to provide 1236 solid precursors by dissolution in a suitable solvent. c -f. A vertical reactor for scalable growth of 1237 graphene wafers, where the 25 wafers can be loaded on the quartz substrate holder (c). The multiple 1238 gas inlet nozzles are designed (d) to improve the uniformity of gas flow, which is simulated based on 1239 finite element method  $(\mathbf{e})^{25}$ . Bourdon gauge (f) and capacitance manometer (g), which are commonly 1240 used to measure the pressure of the vacuum system. Parts d-f adapted with permission from ref 25, 1241 Elsevier. 1242

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FIG. 3 | Schematic of experimental process for growing graphene. a-d, the processes of growing graphene on metal substrates: (a) electrochemical polishing for cleaning and smooth the substrate, (b) heating and annealing to reduce the nucleation sites and enlarge the grain size of metal substrate, (c) high-temperature growth which is dominated by the surface reaction, (d) (d) Precipitation and crumpling during the cooling process. e-g, the processes of growing graphene on dielectric substrates: (e) Cleaning the dielectric substrate, (f) gas-phase reaction dominated growth at high-temperature, (g) thermal contraction induced crumpling during the cooling process.

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FIG.4 | Characterization of CVD-grown graphene. a. Optical microscopy image of the transferred film 1252 on SiO<sub>2</sub>/Si substrate, the layer number can be distinguished by the color contrast<sup>66</sup>. Scale bar 50  $\mu$ m. **b**. 1253 SEM image of graphene domains grown on platinum foil, copper surface roughing changes with the 1254 number of graphene layers<sup>67</sup>. Scale bar 1 mm. **c.** Typical AFM image of graphene grown on copper foil<sup>78</sup>. 1255 Scale bar 2  $\mu$ m. **d.** AFM image of graphene grown on Cu(111), where there are some wrinkles and folds<sup>90</sup>. 1256 Scale bar 1 µm. e. STM image (sample bias -2V, tunnelling current 50 pA) near a corner of a hexagonal 1257 graphene grain on copper foil. Scale bar 1 µm. f. Atomic-resolution STM image corresponding to the 1258 green frame in (e)<sup>80</sup>. Scale bar 3.2 Å. g. Graphene-*h*BN boundary structure imaged by atomic-resolution 1259 STM<sup>89</sup>. Scale bar 1 nm. h. Atomic-resolution TEM image of the typical grain boundary in CVD-grown 1260 graphene film<sup>94</sup>.. Scale bar 0.5 nm. i. Typical Raman spectra of CVD graphene on copper<sup>78</sup>. j. Raman 1261 spectra of monolayer, AB-stacked bilayer and ABA-stacked tri-layer graphene transferred onto SiO<sub>2</sub>/Si 1262 substrates<sup>66</sup>. k. Typical ARPES of the as-grown monolayer graphene on Cu(111)<sup>90</sup>. l. STS spectra of the 1263 graphene films on Cu(111)<sup>90</sup>. ARPES, Angle-resolved photoemission spectroscopy; STM, scanning 1264 tunneling microscopy; STS, scanning tunneling spectroscopy. Parts a, j reprinted from ref. 66, Springer 1265 Nature Limited. Part b reprinted from ref.67, Springer Nature Limited. Parts c, i adapted with permission 1266 from ref 78, American Chemical Society. Parts d, k-l adapted from ref.90, Springer Nature Limited. Parts 1267

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FIG. 5 | Schematic of the typical components of a tube furnace used to grow MoS<sub>2</sub> and similar TMDs. Typical reaction pathway for MoS<sub>2</sub> by thermal CVD is:  $MoO_3(s) + \frac{x}{2}S(g) \xrightarrow{650^{\circ}C} MoO_{3-x}(g) + \frac{x}{2}SO_2;$ Bulk transport of MoO<sub>3-x</sub> (g) and S (g); Surface adsorption of  $MoO_{3-x}$  (g) and S (g);  $MoO_{3-x} + (3 - \frac{x}{2})S \xrightarrow{800^{\circ}C} MoOS_2 + (1 - \frac{x}{2})SO_2;$   $MoOS_2 \xrightarrow{800^{\circ}C} MoS_2(s) + \frac{1}{2}O_2(g);$  Bulk transport of  $O_2$ away from the chamber. An optical microscopy image of typical triangular single crystal MoS<sub>2</sub> monolayers is also shown <sup>129</sup>. Adapted with permission from ref 129, American Chemical Society.

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FIG. 6| Selected examples of CVD polymer processing and applications. a. Roll-to-roll vacuum chamber, 1278 300 mm wide, for CVD polymerization<sup>206</sup>. **b.** An foldable solar cell,  $\sim$  2 cm x 2 cm, fabricated directly on 1279 top of ordinary paper as the substrate, enabled by the low temperature deposition and patterning of a 1280 CVD transparent conducting polymer <sup>207</sup>. c. Dual-scale pattern in silicon, including sub-10 nm lines and 1281 spaces, created using a CVD polymerization<sup>147</sup>. d. Flexible and conformal CVD polymer encapsulation of 1282 a 25 µm diameter lead wire for a biomedical implant<sup>158</sup>. e. A nearly spherical water drop on a 1283 superhydrophobic surface created by a CVD fluoropolymer grown conformally over a nanostructured 1284 array<sup>208</sup>. f. Ultrathin CVD polymer dielectric (pV3D3) for low-power flash memory<sup>209</sup>. (A) Reproduced 1285 with permission<sup>206</sup>. Copyright 2015, Royal Society of Chemistry. (B) Reproduced with permission<sup>207</sup>. 1286 Copyright 2012, Wiley. (C) Reproduced with permission<sup>147</sup>. Copyright 2017, Nature. (D) Reproduced with 1287 permission<sup>158</sup>. Copyright 2007, American Chemical Society. (E) Reproduced with permission<sup>208</sup>. Copyright 1288 2003, American Chemical Society. (F) Reproduced with permission<sup>209</sup>. Copyright 2019, Wiley. Part a 1289

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**FIG. 7** Advances in CVD technology for scaling-up graphene synthesis. a, A timeline highlighting the advances in CVD technology to scale-up graphene synthesis from a manual 2-inch (5 cm) thermal CVD furnace to a fully automated 50 cm wide R2R system. **b** Post-CVD processes that utilize the R2R method for the continuous production of graphene films, including etching and laminated transfer of CVD graphene films to target substrates (Ref.<sup>79</sup>). Part b, image courtesy of Yong Seok Choi, Graphene Square lnc. Part c adapted from ref.79, Springer Nature Limited.

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FIG. 8 | The full roll-to-roll (R2R) production of graphene films. Starting with the R2R CVD synthesis of graphene on copper (yellow), R2R lamination, R2R etching/doping, and R2R patterning/transfer to target substrates (blue) for graphene film production. Figure 8 is reprinted from ref 171, CC BY 4.0 (https://creativecommons.org/licenses/by/4.0/).

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FIG. 9| Important factors that determine the reliability of graphene synthesis, and the corresponding electrical performance data. a. Illustration on the multi-zone heaters with graphite susceptors. b. Reproducibility of sheet resistance for 10 different growth trials. c, Spatial sheet resistance distribution of the graphene films. d. Time-durability of the graphene films monitored at 85 °C with 85% humidity for 12 weeks. Inset: resistivity of the graphene synthesized by rapid thermal CVD as a function of back gate

56 / 63

voltage ( $V_{bg}$ ) at room temperature, which indicates the carrier mobility is as high as 5290 cm2 V<sup>-1</sup> s<sup>-1</sup>. Parts a-d adapted with permission from ref 36, American Chemical Society.

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FIG. 10 | Concept of *in-situ* monitoring of the as-grown CVD graphene on Cu using CLSM. a. The concept of monitoring the as-grown CVD graphene on Cu foil during the continuous roll-to-roll synthetic process using the reflective mode CLSM. **b-d**, The CLSM images of the CVD graphene grown for 10, 13, and 30 min, respectively. Scale bar: 10μm. Figure 10a-d is reprinted from ref 171, CC BY 4.0 (https://creativecommons.org/licenses/by/4.0/).

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1321 Box

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#### [bH1] BOX 1 | CVD categories and variants

**[bH2] Horizontal CVD and vertical CVD** are based on the reactor configurations or the directions of gas flow. The horizontal tube reactor is the most common configuration, where the substrates are mounted horizontally, vertically, or with a tilt angle, to adjust the gas flow. The vertical reactor is usually equipped with a showerhead mixer, which is beneficial for material uniformity and growth rate.

[bH2] Low pressure CVD (LPCVD) and atmospheric pressure CVD (APCVD) are based on the working pressure. In LPCVD, a vacuum pump drives the gas flow. In contrast, APCVD usually does not require a pump and results in a slow flow rate for the reactive gas.

[bH2] Hot-wall CVD and cold-wall CVD refer to the heating methods of thermal CVD. In hot-wall CVD, the entire reaction chamber is heated by an external furnace with a uniform temperature. In cold-wall CVD, only the substrate and its vicinity are heated, and the reactor wall is cold, allowing for rapid heating and cooling. Resistance heating, hot plates, and induction heating methods are common for cold-wall CVD.. [bH2] Plasma-enhanced CVD (PECVD), and photo-assisted CVD and laser-assisted CVD are variants of thermal CVD involving additional components and the introduction of other types of energy to promote the CVD reaction. In PECVD, plasma, a partially ionized high energy gas, is generated by direct current, radio frequency voltage, or microwave sources and coupled to the reactor, resulting in a major drop the reaction temperature. In photo-/laser-assisted CVD, light from a high-intensity lamp or laser is used to promote the deposition.

[bH2] Metal-organic CVD (MOCVD) utilizes metal-organic precursors (usually volatile toxic liquids) that
 are vaporized to form thin films. It is widely used to synthesize III-V compound semiconductors (made of
 elements from groups III and V in the periodic table) for optoelectronics.

[bH2] Hot filament/wire CVD (HFCVD/HWCVD) Resistively-heated filaments (wires) are suspended above a substrate held at a lower temperature. The filaments cause the thermal decomposition, leading to precursors, which then adsorb onto the cooler substrates. A refractory metal such as tungsten, tantalum, or molybdenum, is commonly used as filament material. Typically, inorganic films such as amorphous silicon or silicon nitride are deposited.

**[bH2] Initiated CVD (iCVD)** is a form of HFCVD/HWCVD for growing electrically insulating polymer thin films. The iCVD method utilizes an initiator and monomers as vapor-phase reactants, which absorb and undergo chain-growth polymerization on the cooled substrate. The use of the initiator enables much lower filament temperatures, which preserves the organic functional groups of the monomer. Incorporating the functional groups allows control over the wettability and surface reactivity.

[bH2] oxidative CVD (oCVD) utilizes oxidant and monomer vapours, which undergo spontaneous
 reaction upon adsorption to the substrate. The oCVD produces step-growth polymerization and typically
 results in conducting and semiconducting polymer films.

**[bH2] Atomic layer deposition (ALD) and molecular layer deposition (MLD)** are two similar variants of CVD for depositing inorganic and organic thin films, respectively. For ALD and MLD processes, precursors are introduced sequentially. Self-limiting absorption and surface reactions of the precursors results in layer-by-layer growth of high-quality thin films. Between layers the remaining precursor is purged out by the carrier gas.

# 1363 Glossary terms

- 1364 1. Domain: a region of a single crystal, which is delineated by grain boundaries or the edges of 1365 an isolated island.
- 13662. Raman scattering: an inelastic scattering of photons by matter, by which the energy of incident1367photon is changed.
- 13683. Delamination: a phenomenon where layered composites, thin films or coatings separate from1369the adjacent layers or the substrate due to the weakening of the bonds holding the layers1370together.
- 4. half integer Quantum Hall effect: a novel Hall effect quantized into half integer, owing to the peculiar nature of the Landau levels spectrum with energy spacing in graphene, where the Hall conductivity can be described as  $\sigma_{xy} = 4e^2/h\left(N + \frac{1}{2}\right)$  (*h* is Planck constant and N=0, 1, 2...).
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# 1375 ToC blurb

1376 This Primer on chemical vapour deposition summarizes current and emerging experimental

1377 setups as well as common characterisation approaches used to determine thin film formation

- and quality as applied to graphene and other novel 2D materials.
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#### **Duplicate references:**

**Refs 23 and 24 (** Deng, B. et al. Roll-to-Roll Encapsulation of Metal Nanowires between Graphene and Plastic Substrate for High-Performance Flexible Transparent Electrodes. Nano Lett 15, 4206-4213 (2015).). I deleted Ref 24. Please convert all instances of reference 24 (duplication of 23) to 23 and renumber the references and the reference list accordingly. Note that reference 24 has been deleted from the reference list.

**Refs 39 and 161 (**Reina, A. et al. Large Area, Few-Layer Graphene Films on Arbitrary Substrates by Chemical Vapor Deposition. Nano Lett 9, 30-35 (2009)**). I deleted Ref 161. Please convert all instances of reference 161 (duplication of 39) to 39 and renumber the references and the reference list accordingly. Note that reference 161 has been deleted from the reference list.** 

**Refs 65 and 68 (** Kim, K. S. et al. Large-scale pattern growth of graphene films for stretchable transparent electrodes. Nature 457, 706-710 (2009).**). I deleted Ref 68. Please convert all instances of reference 68 (duplication of 65) to 65 and renumber the references and the reference list accordingly. Note that reference 68 has been deleted from the reference list.** 

**Refs 98 and 99 (**Chen, T. A. et al. Wafer-scale single-crystal hexagonal boron nitride monolayers on Cu (111). Nature 579, 219-223 (2020).) I deleted Ref 99. Please convert all instances of reference 99 (duplication of 98) to 98 and renumber the references and the reference list accordingly. Note that reference 99 has been deleted from the reference list.

#### Out of order references:

Line 271: Ref 68 cited before ref 64-67 (64 is cited line 276). Line 429: Ref 131 cited before refs 126-130.

#### A 'highlighted reference' is missing:

Cai, Z., Liu, B., Zou, X. & Cheng, H. M. Chemical Vapor Deposition Growth and Applications of Two-Dimensional Materials and Their Heterostructures. Chem Rev 118, 6091-6133 (2018). This is a systematic introduction to CVD growth of two-dimensional materials and their hetrostructures.

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Fig 9



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Fig 10

